S-1312xxxH Series

105°C OPERATION LOW CURRENT CONSUMPTION HIGH RIPPLE-REJECTION LOW DROPOUT CMOS VOLTAGE REGULATOR

www.sii-ic.com

Rev.1.1_01

The S-1312xxxH Series, developed by using the CMOS technology, is a positive voltage regulator IC which has low current consumption, high ripple-rejection and low dropout voltage.
Even with low current consumption of 20 μA typ., it has high ripple-rejection of 75 dB typ., and a ceramic capacitor of 0.22 μF or more can be used as the input and output capacitors.
It also has high-accuracy output voltage of ±1.0%.

■ Features

• Output voltage:	1.0 V to 3.5 V, selectable in 0.05 V step
• Input voltage:	1.5 V to 5.5 V
• Output voltage accuracy:	±1.0% (1.0 V to 1.45 V output product: ±15 mV)
• Dropout voltage:	160 mV typ. (2.8 V output product, I_{OUT} = 100 mA)
• Current consumption:	During operation: 20 μA typ., 30 μA max.
	During power-off: 0.1 μA typ., 1.0 μA max.
• Output current:	Possible to output 150 mA ($V_{IN} \geq V_{OUT(S)} + 1.0$ V)*1
• Input and output capacitors:	A ceramic capacitor of 0.22 μF or more can be used.
• Ripple rejection:	75 dB typ. (1.2 V output product, f = 1.0 kHz)
	70 dB typ. (2.85 V output product, f = 1.0 kHz)
• Built-in overcurrent protection circuit:	Limits overcurrent of output transistor.
• Built-in thermal shutdown circuit:	Prevents damage caused by heat.
• Built-in ON / OFF circuit:	Ensures long battery life.
• Pull-down resistor is selectable.	
• Discharge shunt function is selectable.	
• Operation temperature range:	Ta = −40°C to +105°C
• Lead-free (Sn 100%), halogen-free	

***1.** Please make sure that the loss of the IC will not exceed the power dissipation when the output current is large.

■ Applications

- Constant-voltage power supply for battery-powered device
- Constant-voltage power supply for home electric appliance

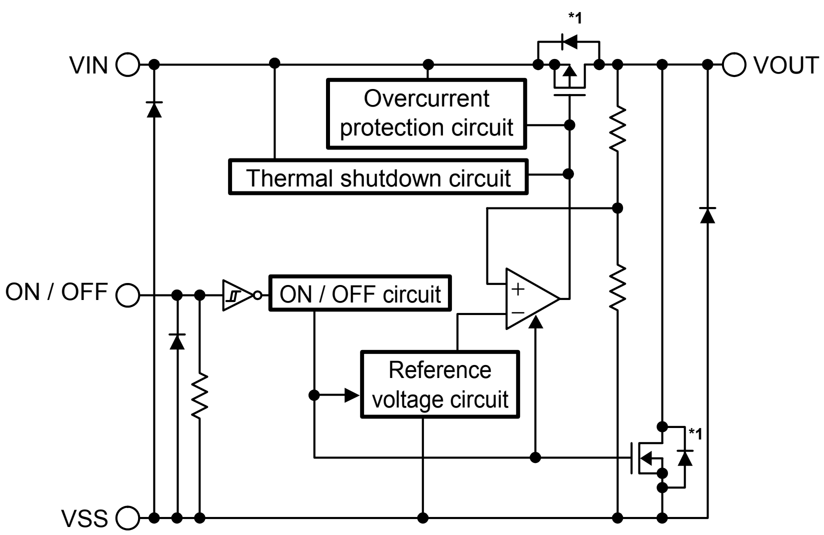
■ Packages

- SOT-23-5
- HSNT-4 (1010)

■ Block Diagrams

1. S-1312xxxH Series A type

Function	Status
ON / OFF logic	Active "H"
Discharge shunt function	Available
Pull-down resistor	Available

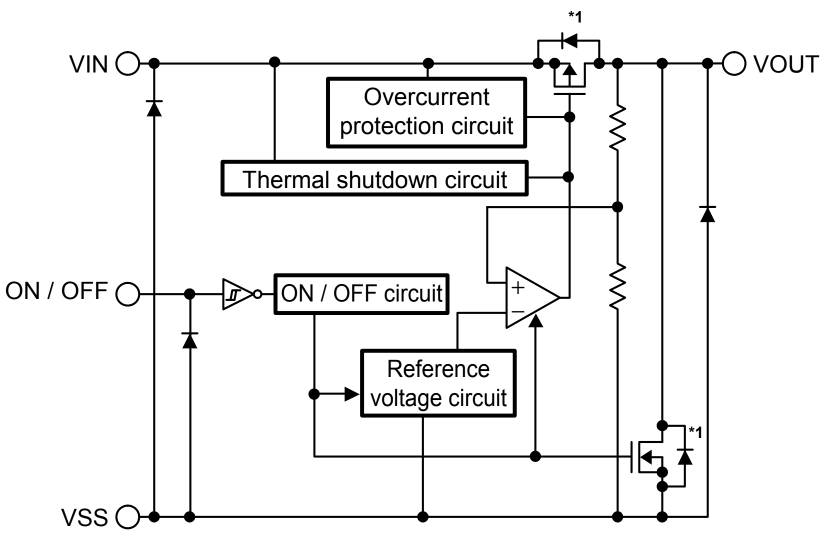


***1.** Parasitic diode

Figure 1

2. S-1312xxxH Series B type

Function	Status
ON / OFF logic	Active "H"
Discharge shunt function	Available
Pull-down resistor	Unavailable

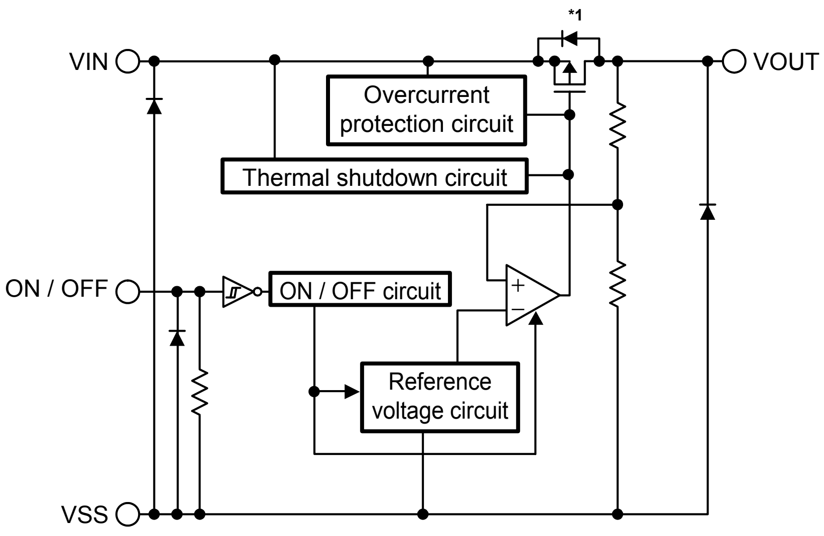


***1.** Parasitic diode

Figure 2

3. S-1312xxxH Series C type

Function	Status
ON / OFF logic	Active "H"
Discharge shunt function	Unavailable
Pull-down resistor	Available

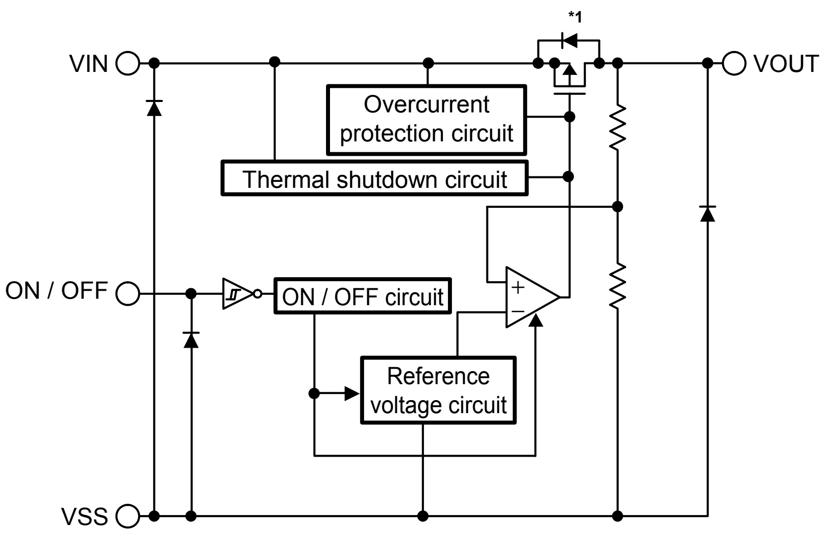


***1.** Parasitic diode

Figure 3

4. S-1312xxxH Series D type

Function	Status
ON / OFF logic	Active "H"
Discharge shunt function	Unavailable
Pull-down resistor	Unavailable



***1.** Parasitic diode

Figure 4

■ Product Name Structure

Users can select the product type, output voltage, and package type for the S-1312xxxH Series. Refer to "**1. Product name**" regarding the contents of product name, "**2. Function list of product types**" regarding the product type, "**3. Packages**" regarding the package drawings, "**4. Product name lists**" regarding details of the product name.

1. Product name

S-1312 x xx H - xxxx U 3

- Environmental code (U)
  U: Lead-free (Sn 100%), halogen-free
- Package abbreviation and IC packing specifications*1 (xxxx)
  M5T1: SOT-23-5, Tape
  A4T2: HSNT-4 (1010), Tape
- Operation temperature (H)
  H: Ta = −40°C to +105°C
- Output voltage*2 (xx)
  10 to 35
  (e.g., when the output voltage is 1.0 V, it is expressed as 10.)
- Product type*3 (x)
  A to D

***1.** Refer to the tape drawing.
***2.** If you request the product which has 0.05 V step, contact our sales office.
***3.** Refer to "**2. Function list of product types**".

2. Function list of product types

Table 1

Product Type	ON / OFF Logic	Discharge Shunt Function	Pull-down Resistor
A	Active "H"	Available	Available
B	Active "H"	Available	Unavailable
C	Active "H"	Unavailable	Available
D	Active "H"	Unavailable	Unavailable

3. Packages

Table 2 Package Drawing Codes

Package Name	Dimension	Tape	Reel	Land
SOT-23-5	MP005-A-P-SD	MP005-A-C-SD	MP005-A-R-SD	−
HSNT-4 (1010)	PL004-A-P-SD	PL004-A-C-SD	PL004-A-R-SD	PL004-A-L-SD

4. Product name lists

4. 1 S-1312xxxH Series A type

ON / OFF logic: Active "H"
Discharge shunt function: Available Pull-down resistor: Available

Table 3

Output Voltage	SOT-23-5	HSNT-4 (1010)
1.0 V ± 15 mV	S-1312A10H-M5T1U3	S-1312A10H-A4T2U3
1.1 V ± 15 mV	S-1312A11H-M5T1U3	S-1312A11H-A4T2U3
1.2 V ± 15 mV	S-1312A12H-M5T1U3	S-1312A12H-A4T2U3
1.25 V ± 15 mV	S-1312A1CH-M5T1U3	S-1312A1CH-A4T2U3
1.3 V ± 15 mV	S-1312A13H-M5T1U3	S-1312A13H-A4T2U3
1.4 V ± 15 mV	S-1312A14H-M5T1U3	S-1312A14H-A4T2U3
1.5 V ± 1.0%	S-1312A15H-M5T1U3	S-1312A15H-A4T2U3
1.6 V ± 1.0%	S-1312A16H-M5T1U3	S-1312A16H-A4T2U3
1.7 V ± 1.0%	S-1312A17H-M5T1U3	S-1312A17H-A4T2U3
1.8 V ± 1.0%	S-1312A18H-M5T1U3	S-1312A18H-A4T2U3
1.85 V ± 1.0%	S-1312A1JH-M5T1U3	S-1312A1JH-A4T2U3
1.9 V ± 1.0%	S-1312A19H-M5T1U3	S-1312A19H-A4T2U3
2.0 V ± 1.0%	S-1312A20H-M5T1U3	S-1312A20H-A4T2U3
2.1 V ± 1.0%	S-1312A21H-M5T1U3	S-1312A21H-A4T2U3
2.2 V ± 1.0%	S-1312A22H-M5T1U3	S-1312A22H-A4T2U3
2.3 V ± 1.0%	S-1312A23H-M5T1U3	S-1312A23H-A4T2U3
2.4 V ± 1.0%	S-1312A24H-M5T1U3	S-1312A24H-A4T2U3
2.5 V ± 1.0%	S-1312A25H-M5T1U3	S-1312A25H-A4T2U3
2.6 V ± 1.0%	S-1312A26H-M5T1U3	S-1312A26H-A4T2U3
2.7 V ± 1.0%	S-1312A27H-M5T1U3	S-1312A27H-A4T2U3
2.8 V ± 1.0%	S-1312A28H-M5T1U3	S-1312A28H-A4T2U3
2.85 V ± 1.0%	S-1312A2JH-M5T1U3	S-1312A2JH-A4T2U3
2.9 V ± 1.0%	S-1312A29H-M5T1U3	S-1312A29H-A4T2U3
3.0 V ± 1.0%	S-1312A30H-M5T1U3	S-1312A30H-A4T2U3
3.1 V ± 1.0%	S-1312A31H-M5T1U3	S-1312A31H-A4T2U3
3.2 V ± 1.0%	S-1312A32H-M5T1U3	S-1312A32H-A4T2U3
3.3 V ± 1.0%	S-1312A33H-M5T1U3	S-1312A33H-A4T2U3
3.4 V ± 1.0%	S-1312A34H-M5T1U3	S-1312A34H-A4T2U3
3.5 V ± 1.0%	S-1312A35H-M5T1U3	S-1312A35H-A4T2U3

Remark Please contact our sales office for products with specifications other than the above.

4. 2 S-1312xxxH Series B type

ON / OFF logic: Active "H"
Discharge shunt function: Available Pull-down resistor: Unavailable

Table 4

Output Voltage	SOT-23-5	HSNT-4 (1010)
1.0 V ± 15 mV	S-1312B10H-M5T1U3	S-1312B10H-A4T2U3
1.1 V ± 15 mV	S-1312B11H-M5T1U3	S-1312B11H-A4T2U3
1.2 V ± 15 mV	S-1312B12H-M5T1U3	S-1312B12H-A4T2U3
1.3 V ± 15 mV	S-1312B13H-M5T1U3	S-1312B13H-A4T2U3
1.4 V ± 15 mV	S-1312B14H-M5T1U3	S-1312B14H-A4T2U3
1.5 V ± 1.0%	S-1312B15H-M5T1U3	S-1312B15H-A4T2U3
1.6 V ± 1.0%	S-1312B16H-M5T1U3	S-1312B16H-A4T2U3
1.7 V ± 1.0%	S-1312B17H-M5T1U3	S-1312B17H-A4T2U3
1.8 V ± 1.0%	S-1312B18H-M5T1U3	S-1312B18H-A4T2U3
1.85 V ± 1.0%	S-1312B1JH-M5T1U3	S-1312B1JH-A4T2U3
1.9 V ± 1.0%	S-1312B19H-M5T1U3	S-1312B19H-A4T2U3
2.0 V ± 1.0%	S-1312B20H-M5T1U3	S-1312B20H-A4T2U3
2.1 V ± 1.0%	S-1312B21H-M5T1U3	S-1312B21H-A4T2U3
2.2 V ± 1.0%	S-1312B22H-M5T1U3	S-1312B22H-A4T2U3
2.3 V ± 1.0%	S-1312B23H-M5T1U3	S-1312B23H-A4T2U3
2.4 V ± 1.0%	S-1312B24H-M5T1U3	S-1312B24H-A4T2U3
2.5 V ± 1.0%	S-1312B25H-M5T1U3	S-1312B25H-A4T2U3
2.6 V ± 1.0%	S-1312B26H-M5T1U3	S-1312B26H-A4T2U3
2.7 V ± 1.0%	S-1312B27H-M5T1U3	S-1312B27H-A4T2U3
2.8 V ± 1.0%	S-1312B28H-M5T1U3	S-1312B28H-A4T2U3
2.85 V ± 1.0%	S-1312B2JH-M5T1U3	S-1312B2JH-A4T2U3
2.9 V ± 1.0%	S-1312B29H-M5T1U3	S-1312B29H-A4T2U3
3.0 V ± 1.0%	S-1312B30H-M5T1U3	S-1312B30H-A4T2U3
3.1 V ± 1.0%	S-1312B31H-M5T1U3	S-1312B31H-A4T2U3
3.2 V ± 1.0%	S-1312B32H-M5T1U3	S-1312B32H-A4T2U3
3.3 V ± 1.0%	S-1312B33H-M5T1U3	S-1312B33H-A4T2U3
3.4 V ± 1.0%	S-1312B34H-M5T1U3	S-1312B34H-A4T2U3
3.5 V ± 1.0%	S-1312B35H-M5T1U3	S-1312B35H-A4T2U3

Remark Please contact our sales office for products with specifications other than the above.

4. 3 S-1312xxxH Series C type

ON / OFF logic: Active "H"
Discharge shunt function: Unavailable Pull-down resistor: Available

Table 5

Output Voltage	SOT-23-5	HSNT-4 (1010)
1.0 V ± 15 mV	S-1312C10H-M5T1U3	S-1312C10H-A4T2U3
1.1 V ± 15 mV	S-1312C11H-M5T1U3	S-1312C11H-A4T2U3
1.2 V ± 15 mV	S-1312C12H-M5T1U3	S-1312C12H-A4T2U3
1.3 V ± 15 mV	S-1312C13H-M5T1U3	S-1312C13H-A4T2U3
1.4 V ± 15 mV	S-1312C14H-M5T1U3	S-1312C14H-A4T2U3
1.5 V ± 1.0%	S-1312C15H-M5T1U3	S-1312C15H-A4T2U3
1.6 V ± 1.0%	S-1312C16H-M5T1U3	S-1312C16H-A4T2U3
1.7 V ± 1.0%	S-1312C17H-M5T1U3	S-1312C17H-A4T2U3
1.8 V ± 1.0%	S-1312C18H-M5T1U3	S-1312C18H-A4T2U3
1.85 V ± 1.0%	S-1312C1JH-M5T1U3	S-1312C1JH-A4T2U3
1.9 V ± 1.0%	S-1312C19H-M5T1U3	S-1312C19H-A4T2U3
2.0 V ± 1.0%	S-1312C20H-M5T1U3	S-1312C20H-A4T2U3
2.1 V ± 1.0%	S-1312C21H-M5T1U3	S-1312C21H-A4T2U3
2.2 V ± 1.0%	S-1312C22H-M5T1U3	S-1312C22H-A4T2U3
2.3 V ± 1.0%	S-1312C23H-M5T1U3	S-1312C23H-A4T2U3
2.4 V ± 1.0%	S-1312C24H-M5T1U3	S-1312C24H-A4T2U3
2.5 V ± 1.0%	S-1312C25H-M5T1U3	S-1312C25H-A4T2U3
2.6 V ± 1.0%	S-1312C26H-M5T1U3	S-1312C26H-A4T2U3
2.7 V ± 1.0%	S-1312C27H-M5T1U3	S-1312C27H-A4T2U3
2.8 V ± 1.0%	S-1312C28H-M5T1U3	S-1312C28H-A4T2U3
2.85 V ± 1.0%	S-1312C2JH-M5T1U3	S-1312C2JH-A4T2U3
2.9 V ± 1.0%	S-1312C29H-M5T1U3	S-1312C29H-A4T2U3
3.0 V ± 1.0%	S-1312C30H-M5T1U3	S-1312C30H-A4T2U3
3.1 V ± 1.0%	S-1312C31H-M5T1U3	S-1312C31H-A4T2U3
3.2 V ± 1.0%	S-1312C32H-M5T1U3	S-1312C32H-A4T2U3
3.3 V ± 1.0%	S-1312C33H-M5T1U3	S-1312C33H-A4T2U3
3.4 V ± 1.0%	S-1312C34H-M5T1U3	S-1312C34H-A4T2U3
3.5 V ± 1.0%	S-1312C35H-M5T1U3	S-1312C35H-A4T2U3

Remark Please contact our sales office for products with specifications other than the above.

4. 4 S-1312xxxH Series D type

ON / OFF logic: Active "H"
Discharge shunt function: Unavailable Pull-down resistor: Unavailable

Table 6

Output Voltage	SOT-23-5	HSNT-4 (1010)
1.0 V ± 15 mV	S-1312D10H-M5T1U3	S-1312D10H-A4T2U3
1.1 V ± 15 mV	S-1312D11H-M5T1U3	S-1312D11H-A4T2U3
1.2 V ± 15 mV	S-1312D12H-M5T1U3	S-1312D12H-A4T2U3
1.3 V ± 15 mV	S-1312D13H-M5T1U3	S-1312D13H-A4T2U3
1.4 V ± 15 mV	S-1312D14H-M5T1U3	S-1312D14H-A4T2U3
1.5 V ± 1.0%	S-1312D15H-M5T1U3	S-1312D15H-A4T2U3
1.6 V ± 1.0%	S-1312D16H-M5T1U3	S-1312D16H-A4T2U3
1.7 V ± 1.0%	S-1312D17H-M5T1U3	S-1312D17H-A4T2U3
1.8 V ± 1.0%	S-1312D18H-M5T1U3	S-1312D18H-A4T2U3
1.85 V ± 1.0%	S-1312D1JH-M5T1U3	S-1312D1JH-A4T2U3
1.9 V ± 1.0%	S-1312D19H-M5T1U3	S-1312D19H-A4T2U3
2.0 V ± 1.0%	S-1312D20H-M5T1U3	S-1312D20H-A4T2U3
2.1 V ± 1.0%	S-1312D21H-M5T1U3	S-1312D21H-A4T2U3
2.2 V ± 1.0%	S-1312D22H-M5T1U3	S-1312D22H-A4T2U3
2.3 V ± 1.0%	S-1312D23H-M5T1U3	S-1312D23H-A4T2U3
2.4 V ± 1.0%	S-1312D24H-M5T1U3	S-1312D24H-A4T2U3
2.5 V ± 1.0%	S-1312D25H-M5T1U3	S-1312D25H-A4T2U3
2.6 V ± 1.0%	S-1312D26H-M5T1U3	S-1312D26H-A4T2U3
2.7 V ± 1.0%	S-1312D27H-M5T1U3	S-1312D27H-A4T2U3
2.8 V ± 1.0%	S-1312D28H-M5T1U3	S-1312D28H-A4T2U3
2.85 V ± 1.0%	S-1312D2JH-M5T1U3	S-1312D2JH-A4T2U3
2.9 V ± 1.0%	S-1312D29H-M5T1U3	S-1312D29H-A4T2U3
3.0 V ± 1.0%	S-1312D30H-M5T1U3	S-1312D30H-A4T2U3
3.1 V ± 1.0%	S-1312D31H-M5T1U3	S-1312D31H-A4T2U3
3.2 V ± 1.0%	S-1312D32H-M5T1U3	S-1312D32H-A4T2U3
3.3 V ± 1.0%	S-1312D33H-M5T1U3	S-1312D33H-A4T2U3
3.4 V ± 1.0%	S-1312D34H-M5T1U3	S-1312D34H-A4T2U3
3.5 V ± 1.0%	S-1312D35H-M5T1U3	S-1312D35H-A4T2U3

Remark Please contact our sales office for products with specifications other than the above.

■ Pin Configurations

1. SOT-23-5

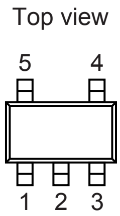


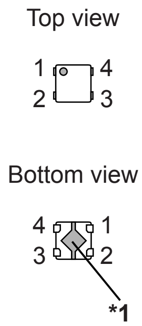
Figure 5

Table 7

Pin No.	Symbol	Description
1	VIN	Input voltage pin
2	VSS	GND pin
3	ON / OFF	ON / OFF pin
4	NC*1	No connection
5	VOUT	Output voltage pin

***1.** The NC pin is electrically open.
The NC pin can be connected to the VIN pin or the VSS pin.

2. HSNT-4 (1010)



***1.** Connect the heat sink of backside at shadowed area to the board, and set electric potential open or GND.
However, do not use it as the function of electrode.

Figure 6

Table 8

Pin No.	Symbol	Description
1	VOUT	Output voltage pin
2	VSS	GND pin
3	ON / OFF	ON / OFF pin
4	VIN	Input voltage pin

■ Absolute Maximum Ratings

Table 9

(Ta = +25°C unless otherwise specified)

Item	Symbol	Absolute Maximum Rating	Unit
Input voltage	V_{IN}	V_{SS} − 0.3 to V_{SS} + 6.0	V
	$V_{ON / OFF}$	V_{SS} − 0.3 to V_{SS} + 6.0	V
Output voltage	V_{OUT}	V_{SS} − 0.3 to V_{IN} + 0.3	V
Output current	I_{OUT}	180	mA
Operation ambient temperature	T_{opr}	−40 to +105	°C
Storage temperature	T_{stg}	−40 to +125	°C

Caution The absolute maximum ratings are rated values exceeding which the product could suffer physical damage. These values must therefore not be exceeded under any conditions.

■ Thermal Resistance Value

Table 10

Item	Symbol	Condition		Min.	Typ.	Max.	Unit
Junction-to-ambient thermal resistance*1	θ_{ja}	SOT-23-5	Board 1	–	192	–	°C/W
			Board 2	–	160	–	°C/W
		HSNT-4 (1010)	Board 1	–	378	–	°C/W
			Board 2	–	317	–	°C/W

***1.** Test environment: compliance with JEDEC STANDARD JESD51-2A

Remark Refer to "■ **Thermal Characteristics**" for details of power dissipation and test board.

■ Electrical Characteristics

Table 11

(Ta = +25°C unless otherwise specified)

Item	Symbol	Condition		Min.	Typ.	Max.	Unit	Test Circuit
Output voltage*1	$V_{OUT(E)}$	$V_{IN} = V_{OUT(S)} + 1.0$ V, $I_{OUT} = 30$ mA	$1.0 \text{ V} \leq V_{OUT(S)} < 1.5$ V	$V_{OUT(S)} - 0.015$	$V_{OUT(S)}$	$V_{OUT(S)} + 0.015$	V	1
			$1.5 \text{ V} \leq V_{OUT(S)} \leq 3.5$ V	$V_{OUT(S)} \times 0.99$	$V_{OUT(S)}$	$V_{OUT(S)} \times 1.01$	V	1
Output current*2	I_{OUT}	$V_{IN} \geq V_{OUT(S)} + 1.0$ V		150*5	−	−	mA	3
Dropout voltage*3	V_{drop}	$I_{OUT} = 100$ mA	$1.0 \text{ V} \leq V_{OUT(S)} < 1.1$ V	0.50	0.68	0.86	V	1
			$1.1 \text{ V} \leq V_{OUT(S)} < 1.2$ V	−	0.52	0.71	V	1
			$1.2 \text{ V} \leq V_{OUT(S)} < 1.3$ V	−	0.31	0.63	V	1
			$1.3 \text{ V} \leq V_{OUT(S)} < 1.4$ V	−	0.28	0.56	V	1
			$1.4 \text{ V} \leq V_{OUT(S)} < 1.5$ V	−	0.26	0.50	V	1
			$1.5 \text{ V} \leq V_{OUT(S)} < 1.7$ V	−	0.24	0.47	V	1
			$1.7 \text{ V} \leq V_{OUT(S)} < 2.0$ V	−	0.22	0.43	V	1
			$2.0 \text{ V} \leq V_{OUT(S)} < 2.5$ V	−	0.18	0.36	V	1
			$2.5 \text{ V} \leq V_{OUT(S)} < 3.0$ V	−	0.16	0.32	V	1
			$3.0 \text{ V} \leq V_{OUT(S)} < 3.3$ V	−	0.15	0.28	V	1
			$3.3 \text{ V} \leq V_{OUT(S)} \leq 3.5$ V	−	0.14	0.27	V	1
Line regulation	$\frac{\Delta V_{OUT1}}{\Delta V_{IN} \bullet V_{OUT}}$	$1.0 \text{ V} \leq V_{OUT(S)} < 1.1$ V $1.6 \text{ V} \leq V_{IN} \leq 5.5$V, $I_{OUT} = 30$ mA		−	0.02	0.1	%/V	1
		$1.1 \text{ V} \leq V_{OUT(S)} \leq 3.5$ V $V_{OUT(S)} + 0.5 \text{ V} \leq V_{IN} \leq 5.5$ V, $I_{OUT} = 30$ mA		−	0.02	0.1	%/V	1
Load regulation	ΔV_{OUT2}	$V_{IN} = V_{OUT(S)} + 1.0$ V, $100\ \mu\text{A} \leq I_{OUT} \leq 100$ mA		−	20	40	mV	1
Output voltage temperature coefficient*4	$\frac{\Delta V_{OUT}}{\Delta Ta \bullet V_{OUT}}$	$V_{IN} = V_{OUT(S)} + 1.0$ V, $I_{OUT} = 30$ mA, $-40°\text{C} \leq Ta \leq +105°\text{C}$		−	±130	−	ppm/°C	1
Current consumption during operation	I_{SS1}	$V_{IN} = V_{OUT(S)} + 1.0$ V, ON / OFF pin = ON, no load		−	20	30	μA	2
Current consumption during power-off	I_{SS2}	$V_{IN} = V_{OUT(S)} + 1.0$ V, ON / OFF pin = OFF, no load		−	0.1	1.0	μA	2
Input voltage	V_{IN}	−		1.5	−	5.5	V	−
ON / OFF pin input voltage "H"	V_{SH}	$V_{IN} = V_{OUT(S)} + 1.0$ V, $R_L = 1.0$ kΩ determined by V_{OUT} output level		1.0	−	−	V	4
ON / OFF pin input voltage "L"	V_{SL}	$V_{IN} = V_{OUT(S)} + 1.0$ V, $R_L = 1.0$ kΩ determined by V_{OUT} output level		−	−	0.25	V	4
ON / OFF pin input current "H"	I_{SH}	$V_{IN} = 5.5$ V, $V_{ON / OFF} = 5.5$ V	B / D type (without pull-down registor)	−0.1	−	0.1	μA	4
			A / C type (with pull-down registor)	1.0	2.5	5.0	μA	4
ON / OFF pin input current "L"	I_{SL}	$V_{IN} = 5.5$ V, $V_{ON / OFF} = 0$ V		−0.1	−	0.1	μA	4
Ripple rejection	$\lvert RR \rvert$	$V_{IN} = V_{OUT(S)} + 1.0$ V, f = 1.0 kHz, $\Delta V_{rip} = 0.5$ Vrms, $I_{OUT} = 30$ mA	$1.0 \text{ V} \leq V_{OUT(S)} \leq 1.2$ V	−	75	−	dB	5
			$1.2 \text{ V} < V_{OUT(S)} \leq 2.85$ V	−	70	−	dB	5
			$2.85 \text{ V} < V_{OUT(S)} \leq 3.5$ V	−	65	−	dB	5
Short-circuit current	I_{short}	$V_{IN} = V_{OUT(S)} + 1.0$ V, ON / OFF pin = ON, $V_{OUT} = 0$ V		−	50	−	mA	3
Thermal shutdown detection temperature	T_{SD}	Junction temperature		−	150	−	°C	−
Thermal shutdown release temperature	T_{SR}	Junction temperature		−	120	−	°C	−
"L" output Nch ON resistance	R_{LOW}	$V_{OUT} = 0.1$ V, $V_{IN} = 5.5$ V	A / B type (with discharge shuntfunction)	−	35	−	Ω	3
Power-off pull-down resistance	R_{PD}	−	A / C type (with pull-down registor)	1.0	2.2	5.0	MΩ	4

***1.** $V_{OUT(S)}$: Set output voltage
$V_{OUT(E)}$: Actual output voltage
Output voltage when fixing I_{OUT} (= 30 mA) and inputting $V_{OUT(S)} + 1.0$ V

***2.** The output current at which the output voltage becomes 95% of $V_{OUT(E)}$ after gradually increasing the output current.

***3.** $V_{drop} = V_{IN1} - (V_{OUT3} \times 0.98)$
V_{OUT3} is the output voltage when $V_{IN} = V_{OUT(S)} + 1.0$ V and $I_{OUT} = 100$ mA.
V_{IN1} is the input voltage at which the output voltage becomes 98% of V_{OUT3} after gradually decreasing the input voltage.

***4.** A change in the temperature of the output voltage [mV/°C] is calculated using the following equation.

$$\frac{\Delta V_{OUT}}{\Delta Ta}\,[\mathrm{mV/°C}]^{*1} = V_{OUT(S)}\,[\mathrm{V}]^{*2} \times \frac{\Delta V_{OUT}}{\Delta Ta \bullet V_{OUT}}\,[\mathrm{ppm/°C}]^{*3} \div 1000$$

***1.** Change in temperature of output voltage
***2.** Set output voltage
***3.** Output voltage temperature coefficient

***5.** The output current can be at least this value.
Due to limitation of the power dissipation, this value may not be satisfied. Attention should be paid to the power dissipation when the output current is large.
This specification is guaranteed by design.

■ Test Circuits

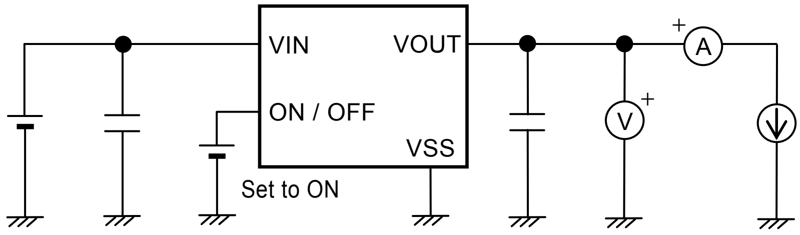


Figure 7 Test Circuit 1

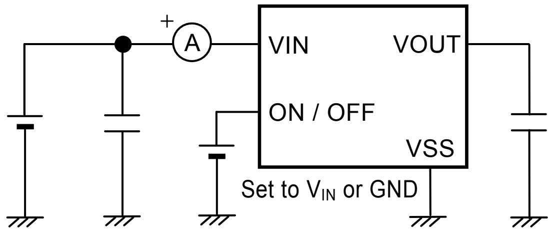


Figure 8 Test Circuit 2

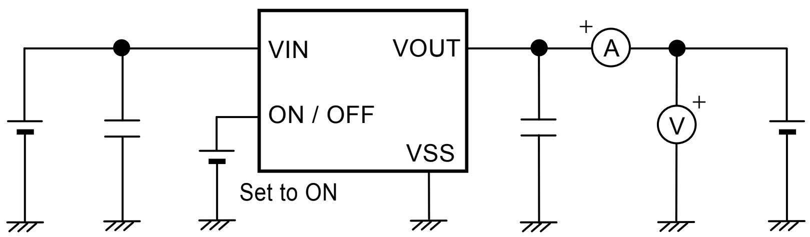


Figure 9 Test Circuit 3

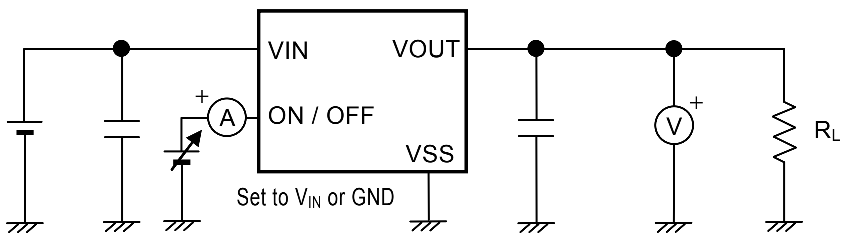


Figure 10 Test Circuit 4

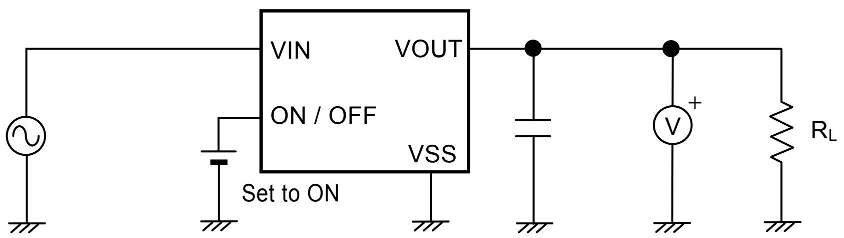
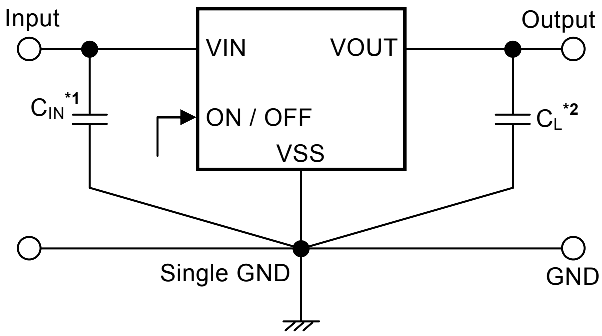


Figure 11 Test Circuit 5

■ Standard Circuit



***1.** C_{IN} is a capacitor for stabilizing the input.
***2.** A ceramic capacitor of 0.22 μF or more can be used as C_L.

Figure 12

Caution The above connection diagram and constant will not guarantee successful operation. Perform thorough evaluation using the actual application to set the constant.

■ Condition of Application

Input capacitor (C_{IN}): 0.22 μF or more
Output capacitor (C_L): 0.22 μF or more

Caution Generally a series regulator may cause oscillation, depending on the selection of external parts. Confirm that no oscillation occurs in the application for which the above capacitors are used.

■ Selection of Input and Output Capacitors (C_{IN}, C_L)

The S-1312xxxH Series requires an output capacitor between the VOUT pin and the VSS pin for phase compensation. Operation is stabilized by a ceramic capacitor with an output capacitance of 0.22 μF or more over the entire temperature range. When using an OS capacitor, a tantalum capacitor, or an aluminum electrolytic capacitor, the capacitance must be 0.22 μF or more.
The value of the output overshoot or undershoot transient response varies depending on the value of the output capacitor. The required capacitance of the input capacitor differs depending on the application.
The recommended capacitance for an application is $C_{IN} \geq 0.22$ μF, $C_L \geq 0.22$ μF; however, when selecting the output capacitor, perform sufficient evaluation, including evaluation of temperature characteristics, on the actual device.

■ Explanation of Terms

1. Low dropout voltage regulator

This voltage regulator has the low dropout voltage due to its built-in low on-resistance transistor.

2. Output voltage (V_{OUT})

The accuracy of the output voltage is ensured at ±1.0% or ±15 mV*1 under the specified conditions of fixed input voltage*2, fixed output current, and fixed temperature.

***1.** When V_{OUT} < 1.5 V: ±15 mV, when $V_{OUT} \geq$ 1.5 V: ±1.0%
***2.** Differs depending on the product.

Caution If the above conditions change, the output voltage value may vary and exceed the accuracy range of the output voltage. Refer to "■ Electrical Characteristics" and "■ Characteristics (Typical Data)" for details.

3. Line regulation $\left(\frac{\Delta V_{OUT1}}{\Delta V_{IN} \bullet V_{OUT}}\right)$

Indicates the dependency of the output voltage on the input voltage. That is, the values show how much the output voltage changes due to a change in the input voltage with the output current remaining unchanged.

4. Load regulation (ΔV_{OUT2})

Indicates the dependency of the output voltage on the output current. That is, the values show how much the output voltage changes due to a change in the output current with the input voltage remaining unchanged.

5. Dropout voltage (V_{drop})

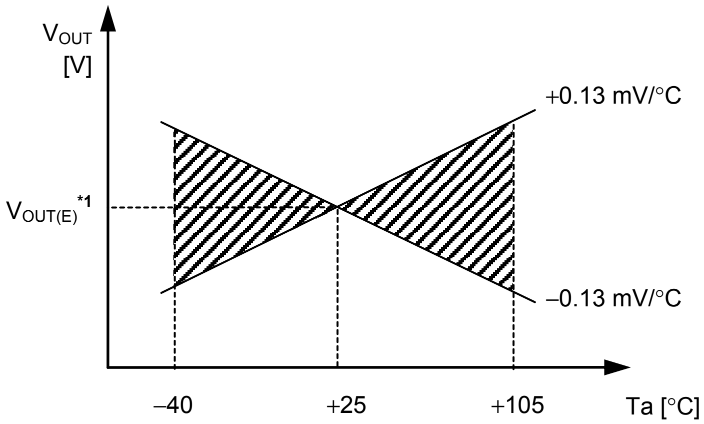
Indicates the difference between input voltage (V_{IN1}) and the output voltage when; decreasing input voltage (V_{IN}) gradually until the output voltage has dropped out to the value of 98% of output voltage (V_{OUT3}), which is at $V_{IN} = V_{OUT(S)} + 1.0$ V.

$V_{drop} = V_{IN1} - (V_{OUT3} \times 0.98)$

6. Output voltage temperature coefficient $\left(\frac{\Delta V_{OUT}}{\Delta Ta \bullet V_{OUT}}\right)$

The shaded area in **Figure 13** is the range where V_{OUT} varies in the operation temperature range when the output voltage temperature coefficient is ±130 ppm/°C.

Example of S-1312A10H typ. product



***1.** $V_{OUT(E)}$ is the value of the output voltage measured at Ta = +25°C.

Figure 13

A change in the temperature of the output voltage [mV/°C] is calculated using the following equation.

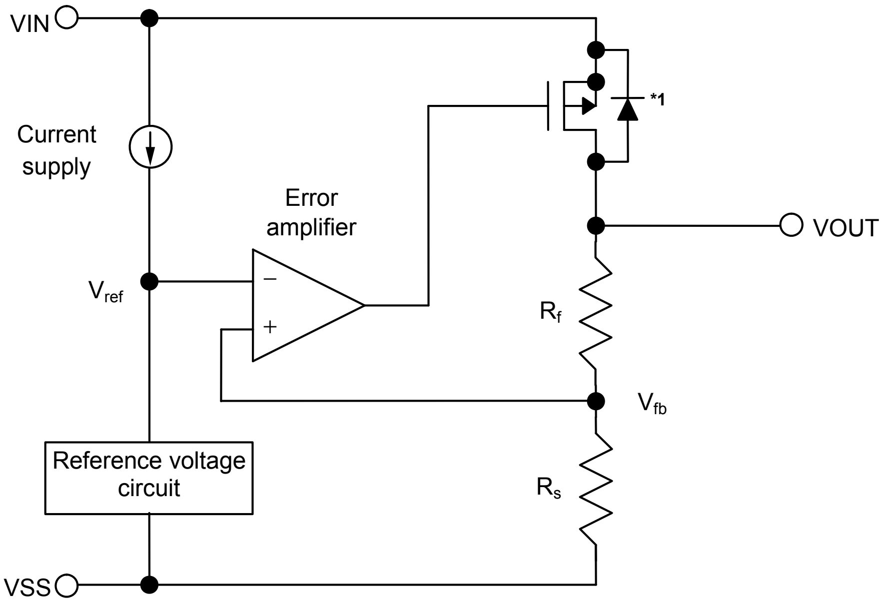
$$\frac{\Delta V_{OUT}}{\Delta Ta} [mV/°C]^{*1} = V_{OUT(S)} [V]^{*2} \times \frac{\Delta V_{OUT}}{\Delta Ta \bullet V_{OUT}} [ppm/°C]^{*3} \div 1000$$

***1.** Change in temperature of output voltage
***2.** Set output voltage
***3.** Output voltage temperature coefficient

■ Operation

1. Basic operation

Figure 14 shows the block diagram of the S-1312xxxH Series.
The error amplifier compares the reference voltage (V_{ref}) with feedback voltage (V_{fb}), which is the output voltage resistance-divided by feedback resistors (R_s and R_f). It supplies the gate voltage necessary to maintain the constant output voltage which is not influenced by the input voltage and temperature change, to the output transistor.



***1**. Parasitic diode

Figure 14

2. Output transistor

In the S-1312xxxH Series, a low on-resistance P-channel MOS FET is used as the output transistor.
Be sure that V_{OUT} does not exceed V_{IN} + 0.3 V to prevent the voltage regulator from being damaged due to inverse current flowing from the VOUT pin through a parasitic diode to the VIN pin, when the potential of V_{OUT} became higher than V_{IN}.

3. ON / OFF pin

This pin starts and stops the regulator.

When the ON / OFF pin is set to OFF level, the entire internal circuit stops operating, and the built-in P-channel MOS FET output transistor between the VIN pin and the VOUT pin is turned off, reducing current consumption significantly.
Note that the current consumption increases when a voltage of 0.25 V to V_{IN} – 0.3 V is applied to the ON / OFF pin.
The ON / OFF pin is configured as shown in **Figure 15** and **Figure 16**.

3. 1 S-1312xxxH Series A / C type

The ON / OFF pin is internally pulled down to the VSS pin in the floating status, so the VOUT pin is set to the V_{SS} level.
For the ON / OFF pin current, refer to the A / C type of the ON / OFF pin input current "H" in "■ **Electrical Characteristics**".

3. 2 S-1312xxxH Series B / D type

The ON / OFF pin is internally not pulled up or pulled down, so do not use this pin in the floating status. When not using the ON / OFF pin, connect the pin to the VIN pin.

Table 12

Product Type	ON / OFF Pin	Internal Circuit	VOUT Pin Voltage	Current Consumption
A / B / C / D	"H": ON	Operate	Set value	I_{SS1}*1
A / B / C / D	"L": OFF	Stop	V_{SS} level	I_{SS2}

***1**. Note that the IC's current consumption increases as much as current flows into the pull-down resistor when the ON / OFF pin is connected to the VIN pin and the S-1312xxxH Series A / C type is operating (refer to **Figure 15**).

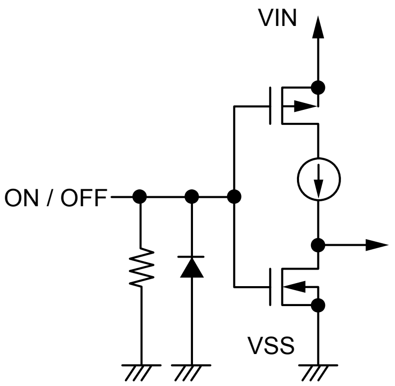


Figure 15 S-1312xxxH Series A / C Type

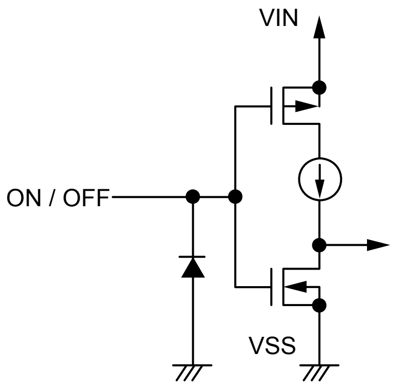


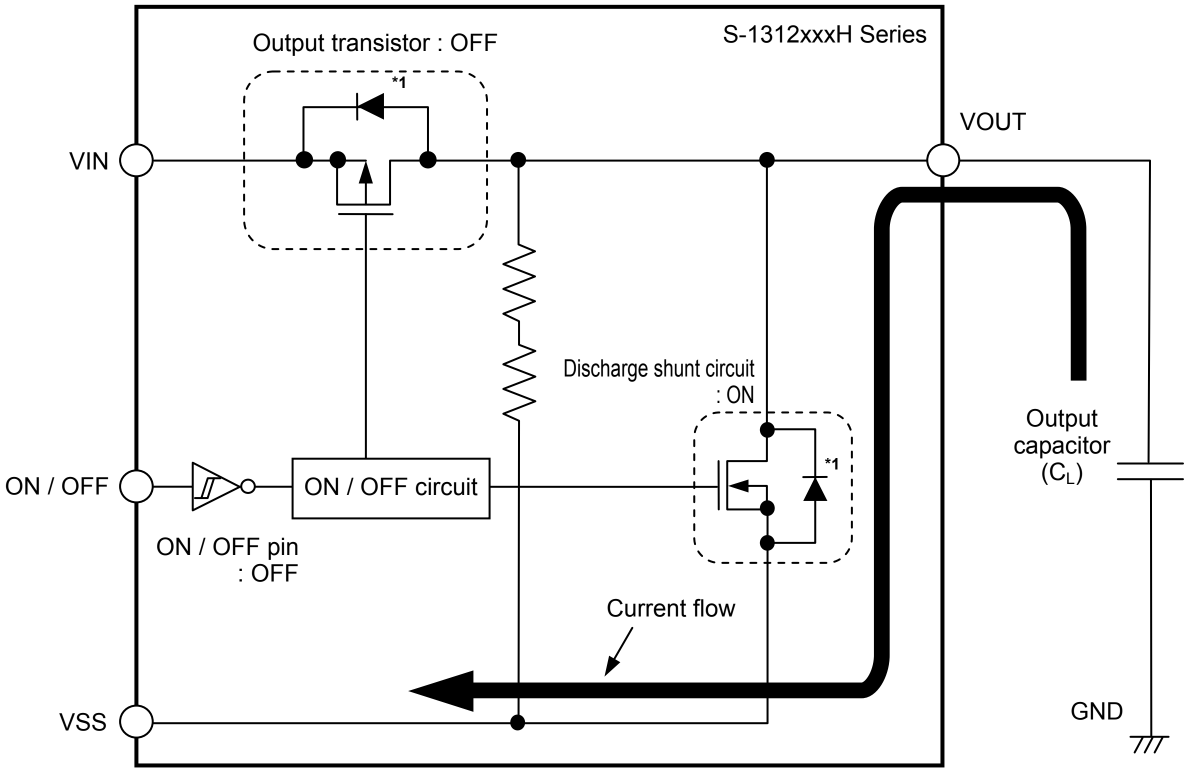
Figure 16 S-1312xxxH Series B / D Type

4. Discharge shunt function (S-1312xxxH Series A / B type)

The S-1312xxxH Series A / B type has a built-in discharge shunt circuit to discharge the output capacitance. The output capacitance is discharged as follows so that the VOUT pin reaches the V_{SS} level.

(1) The ON / OFF pin is set to OFF level.
(2) The output transistor is turned off.
(3) The discharge shunt circuit is turned on.
(4) The output capacitor discharges.

Since the S-1312xxxH Series C / D type does not have a discharge shunt circuit, the VOUT pin is set to the V_{SS} level through several hundred kΩ internal divided resistors between the VOUT pin and the VSS pin. The S-1312xxxH Series A / B type allows the VOUT pin to reach the V_{SS} level rapidly due to the discharge shunt circuit.



***1**. Parasitic diode

Figure 17

5. Pull-down resistor (S-1312xxxH Series A / C type)

The ON / OFF pin is internally pulled down to the VSS pin in the floating status, so the VOUT pin is set to the V_{SS} level.

Note that the IC's current consumption increases as much as current flows into the pull-down resistor of 2.2 MΩ typ. when the ON / OFF pin is connected to the VIN pin and the S-1312xxxH Series A / C type is operating.

6. Overcurrent protection circuit

The S-1312xxxH Series includes an overcurrent protection circuit having the characteristics shown in "**1. Output voltage vs. Output current (When load current increases) (Ta = +25°C)**" in "**■ Characteristics (Typical Data)**", in order to protect the output transistor against an excessive output current and short circuiting between the VOUT pin and the VSS pin. The current when the output pin is short-circuited (I_{short}) is internally set at approx. 50 mA typ., and the normal value is restored for the output voltage, if releasing a short circuit once.

Caution This overcurrent protection circuit does not work as for thermal protection. If this IC long keeps short circuiting inside, pay attention to the conditions of input voltage and load current so that, under the usage conditions including short circuit, the loss of the IC will not exceed power dissipation.

7. Thermal shutdown circuit

The S-1312xxxH Series has a thermal shutdown circuit to protect the device from damage due to overheat. When the junction temperature rises to 150°C typ., the thermal shutdown circuit operates to stop regulating. When the junction temperature drops to 120°C typ., the thermal shutdown circuit is released to restart regulating.
Due to self-heating of the S-1312xxxH Series, if the thermal shutdown circuit starts operating, it stops regulating so that the output voltage drops. When regulation stops, the S-1312xxxH Series does not itself generate heat and the IC's temperature drops. When the temperature drops, the thermal shutdown circuit is released to restart regulating, thus the S-1312xxxH Series generates heat again. Repeating this procedure makes the waveform of the output voltage into a pulse-like form. Stop or restart of regulation continues unless decreasing either or both of the input voltage and the output current in order to reduce the internal power consumption, or decreasing the ambient temperature.

Table 13

Thermal Shutdown Circuit	VOUT Pin Voltage
Operate: 150°C typ.*1	V_{SS} level
Release: 120°C typ.*1	Set value

***1.** Junction temperature

■ Precautions

- Wiring patterns for the VIN pin, the VOUT pin and GND should be designed so that the impedance is low. When mounting an output capacitor between the VOUT pin and the VSS pin (C_L) and a capacitor for stabilizing the input between the VIN pin and the VSS pin (C_{IN}), the distance from the capacitors to these pins should be as short as possible.
- Note that generally the output voltage may increase when a series regulator is used at low load current (1.0 mA or less).
- Note that generally the output voltage may increase due to the leakage current from an output driver when a series regulator is used at high temperature.
- Note that the output voltage may increase due to the leakage current from an output driver even if the ON / OFF pin is at OFF level when a series regulator is used at high temperature.
- Generally a series regulator may cause oscillation, depending on the selection of external parts. The following conditions are recommended for the S-1312xxxH Series. However, be sure to perform sufficient evaluation under the actual usage conditions for selection, including evaluation of temperature characteristics. Refer to "**5. Example of equivalent series resistance vs. Output current characteristics (Ta = +25°C)**" in "**■ Reference Data**" for the equivalent series resistance (R_{ESR}) of the output capacitor.

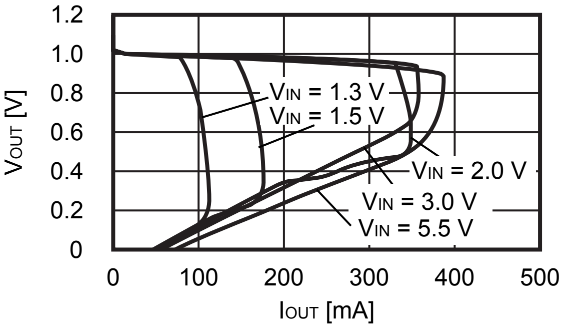
  Input capacitor (C_{IN}): 0.22 μF or more
  Output capacitor (C_L): 0.22 μF or more

- The voltage regulator may oscillate when the impedance of the power supply is high and the input capacitance is small or an input capacitor is not connected.
- If the output capacitance is small, power supply's fluctuation and the characteristics of load fluctuation become worse. Sufficiently evaluate the output voltage's fluctuation with the actual device.
- Overshoot may occur in the output voltage momentarily if the voltage is rapidly raised at power-on or when the power supply fluctuates. Sufficiently evaluate the output voltage at power-on with the actual device.
- The application conditions for the input voltage, the output voltage, and the load current should not exceed the power dissipation.
- Do not apply an electrostatic discharge to this IC that exceeds the performance ratings of the built-in electrostatic protection circuit.
- In determining the output current, attention should be paid to the output current value specified in **Table 11** in "**■ Electrical Characteristics**" and footnote ***5** of the table.
- SII Semiconductor Corporation claims no responsibility for any disputes arising out of or in connection with any infringement by products including this IC of patents owned by a third party.

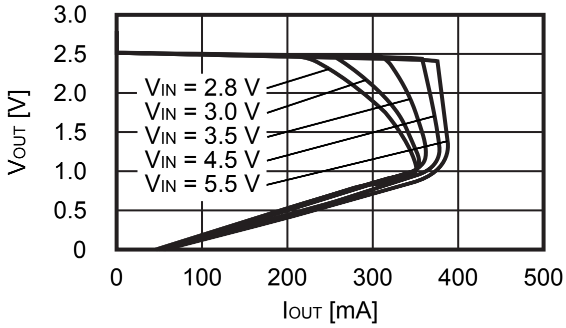
■ Characteristics (Typical Data)

1. Output voltage vs. Output current (When load current increases) (Ta = +25°C)

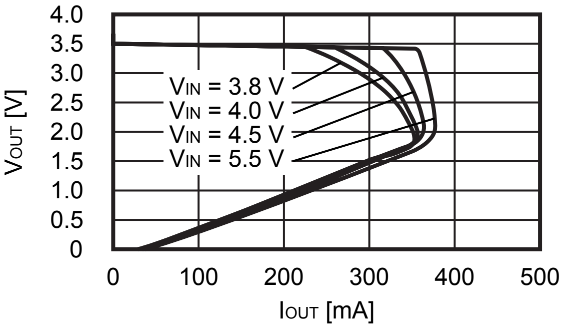
1. 1 V_{OUT} = 1.0 V



1. 2 V_{OUT} = 2.5 V



1. 3 V_{OUT} = 3.5 V

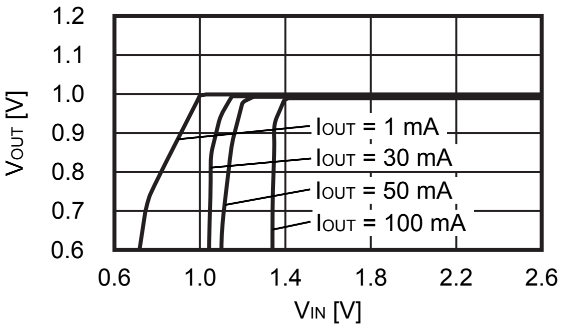


Remark In determining the output current, attention should be paid to the following.

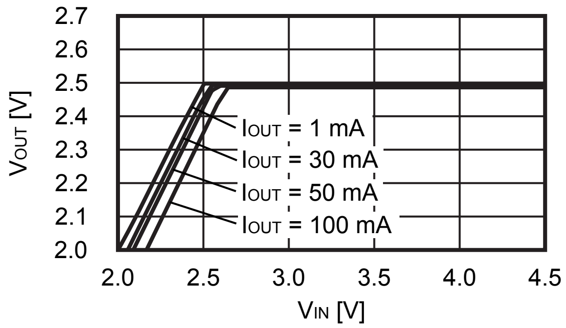
1. The minimum output current value and footnote ***5** in **Table 11** in "**■ Electrical Characteristics**"
2. Power dissipation

2. Output voltage vs. Input voltage (Ta = +25°C)

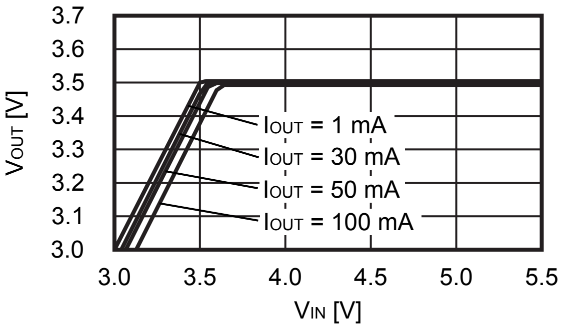
2. 1 V_{OUT} = 1.0 V



2. 2 V_{OUT} = 2.5 V

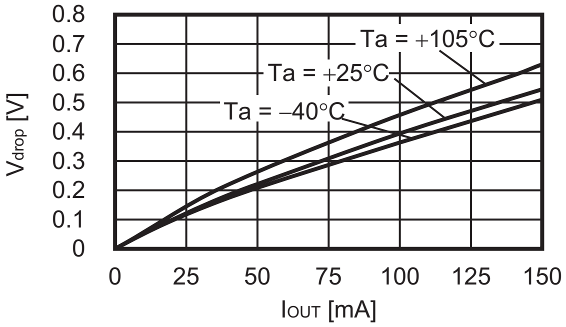


2. 3 V_{OUT} = 3.5 V

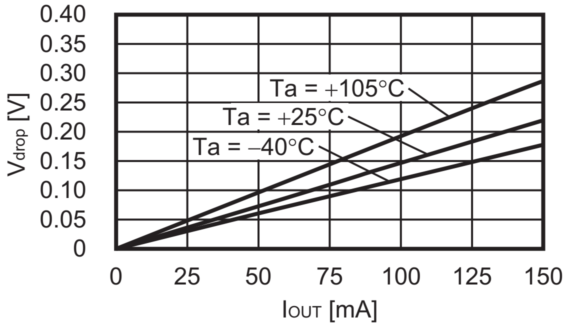


3. Dropout voltage vs. Output current

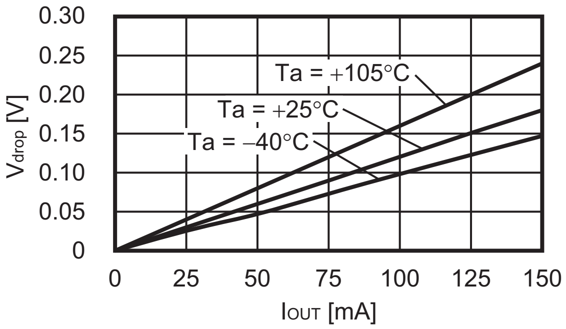
3. 1 V_{OUT} = 1.0 V



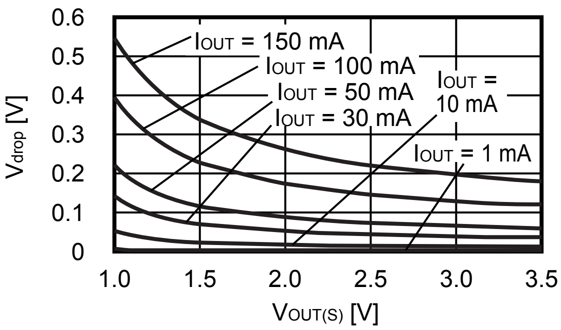
3. 2 V_{OUT} = 2.5 V



3. 3 V_{OUT} = 3.5 V

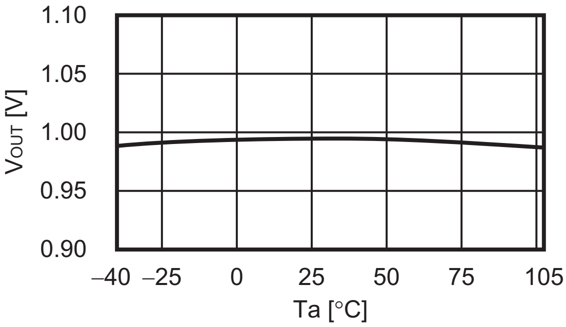


4. Dropout voltage vs. Set output voltage

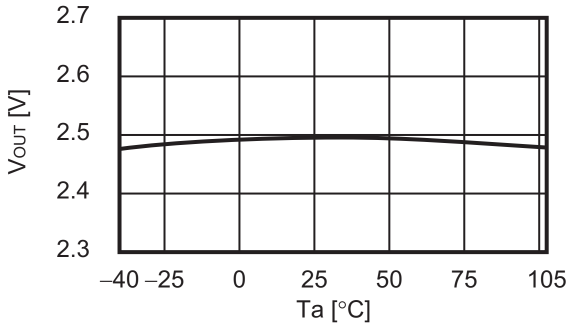


5. Output voltage vs. Ambient temperature

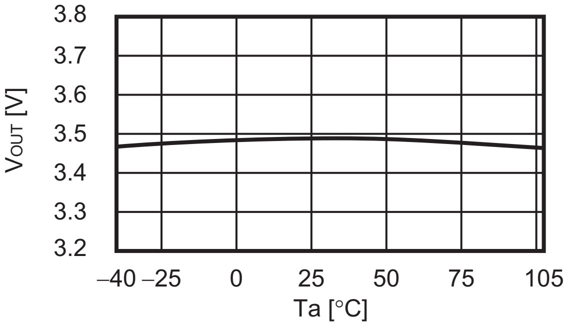
5. 1 V_{OUT} = 1.0 V



5. 2 V_{OUT} = 2.5 V

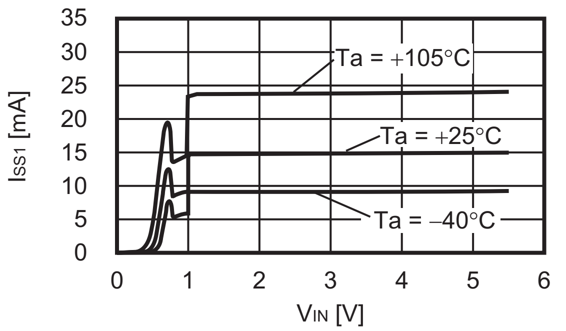


5. 3 V_{OUT} = 3.5 V

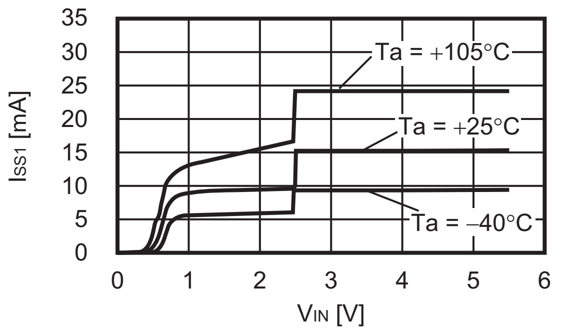


6. Current consumption vs. Input voltage

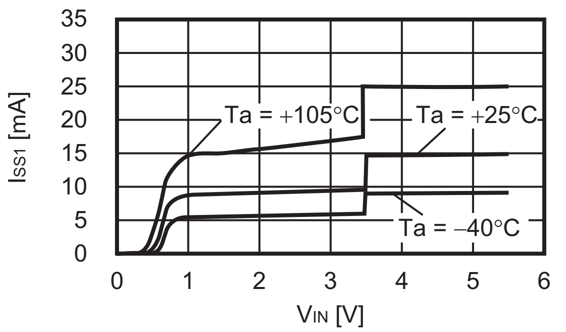
6. 1 V_{OUT} = 1.0 V



6. 2 V_{OUT} = 2.5 V

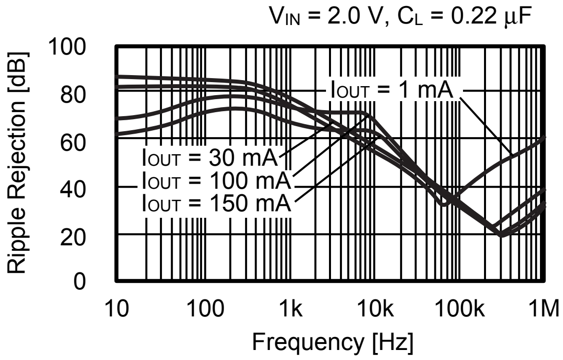


6. 3 V_{OUT} = 3.5 V

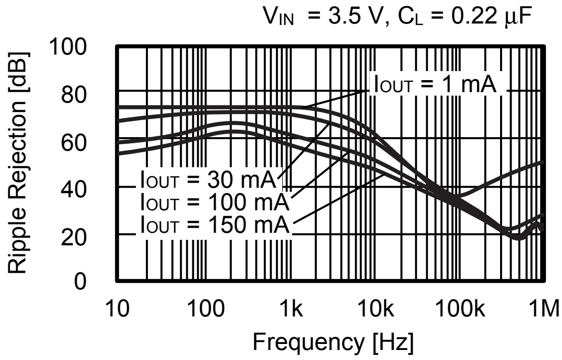


7. Ripple rejection (Ta = +25°C)

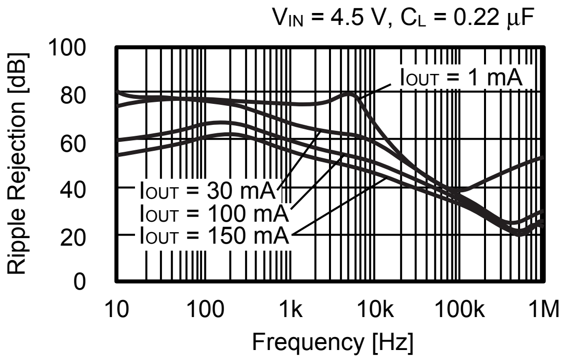
7. 1 V_{OUT} = 1.0 V



7. 2 V_{OUT} = 2.5 V



7. 3 V_{OUT} = 3.5 V

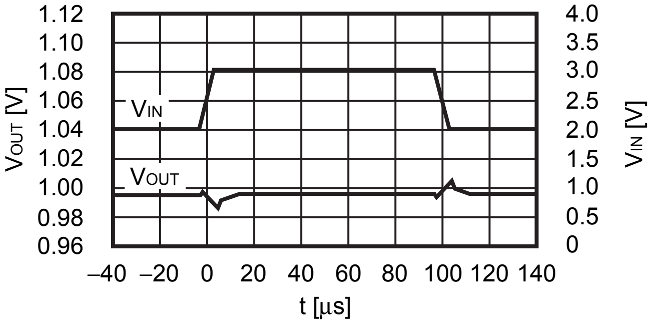


■ Reference Data

1. Transient response characteristics when input (Ta = +25°C)

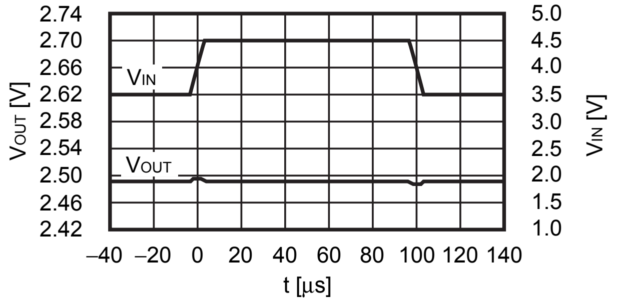
1. 1 V_{OUT} = 1.0 V

I_{OUT} = 30 mA, C_L = 0.22 μF, V_{IN} = 2.0 V ↔ 3.0 V, t_r = t_f = 5.0 μs



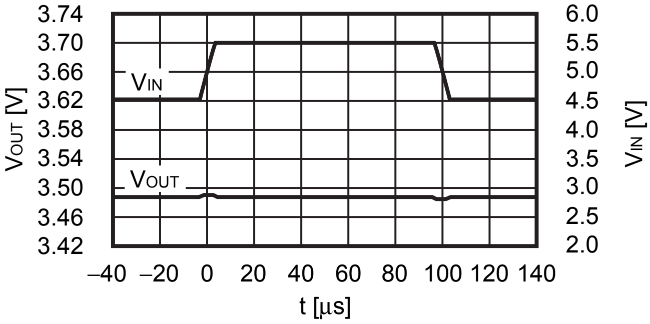
1. 2 V_{OUT} = 2.5 V

I_{OUT} = 30 mA, C_L = 0.22 μF, V_{IN} = 3.5 V ↔ 4.5 V, t_r = t_f = 5.0 μs



1. 3 V_{OUT} = 3.5 V

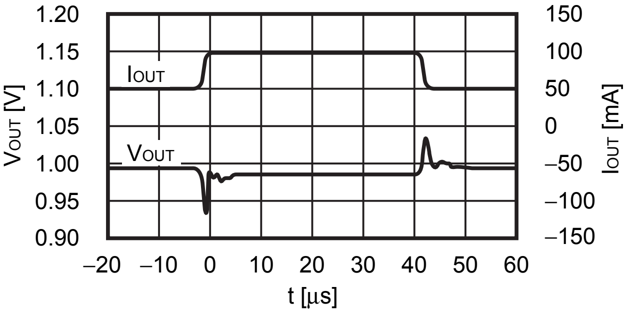
I_{OUT} = 30 mA, C_L = 0.22 μF, V_{IN} = 4.5 V ↔ 5.5 V, t_r = t_f = 5.0 μs



2. Transient response characteristics of load (Ta = +25°C)

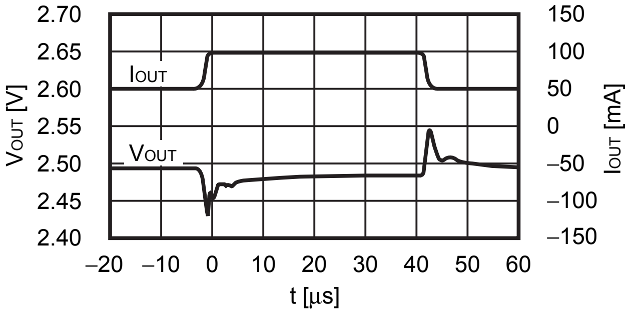
2. 1 V_{OUT} = 1.0 V

V_{IN} = 2.0 V, C_{IN} = C_L = 0.22 μF, I_{OUT} = 50 mA ↔ 100 mA



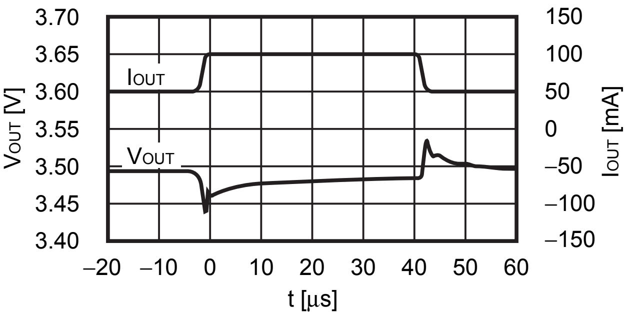
2. 2 V_{OUT} = 2.5 V

V_{IN} = 3.5 V, C_{IN} = C_L = 0.22 μF, I_{OUT} = 50 mA ↔ 100 mA



2. 3 V_{OUT} = 3.5 V

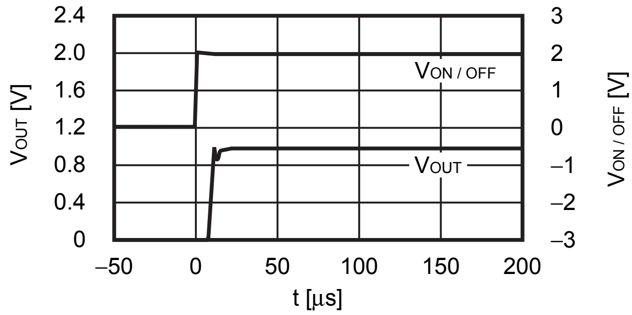
V_{IN} = 4.5 V, C_{IN} = C_L = 0.22 μF, I_{OUT} = 50 mA ↔ 100 mA



3. Transient response characteristics of ON / OFF pin (Ta = +25°C)

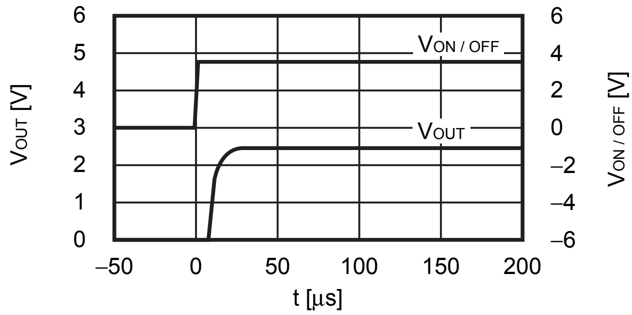
3. 1 V_{OUT} = 1.0 V

V_{IN} = 2.0 V, C_{IN} = C_L = 0.22 μF, I_{OUT} = 100 mA,
$V_{ON / OFF}$ = 0 V → 2.0 V, t_r = 1.0 μs



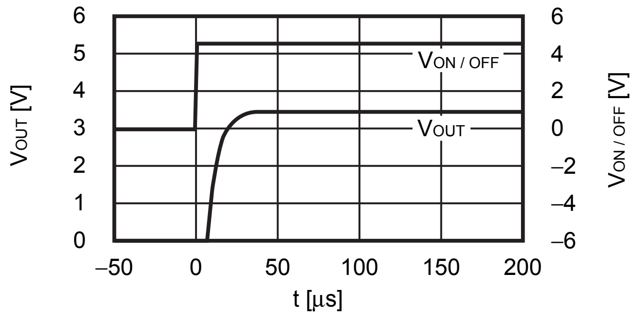
3. 2 V_{OUT} = 2.5 V

V_{IN} = 3.5 V, C_{IN} = C_L = 0.22 μF, I_{OUT} = 100 mA,
$V_{ON / OFF}$ = 0 V → 3.5 V, t_r = 1.0 μs



3. 3 V_{OUT} = 3.5 V

V_{IN} = 4.5 V, C_{IN} = C_L = 0.22 μF, I_{OUT} = 100 mA,
$V_{ON / OFF}$ = 0 V → 4.5 V, t_r = 1.0 μs



4. Output capacitance vs. Characteristics of discharge time (Ta = +25°C)

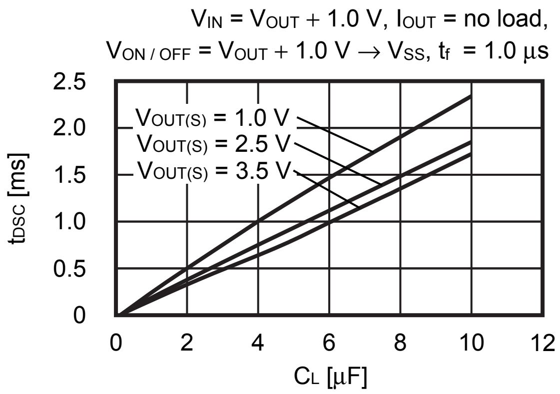


Figure 18 S-1312xxxH Series A / B Type (with discharge shunt function)

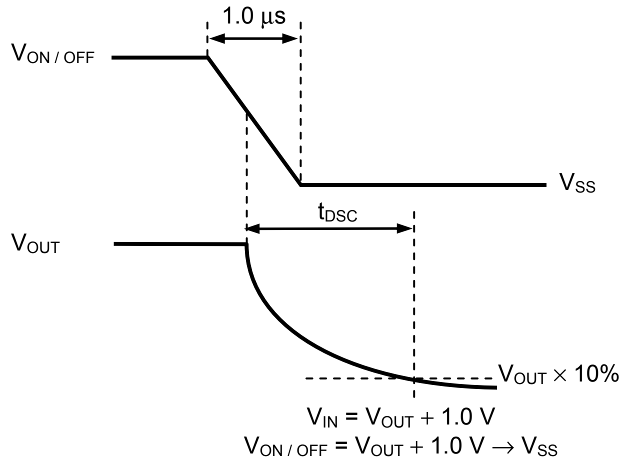


Figure 19 Measurement Condition of Discharge Time

5. Example of equivalent series resistance vs. Output current characteristics (Ta = +25°C)

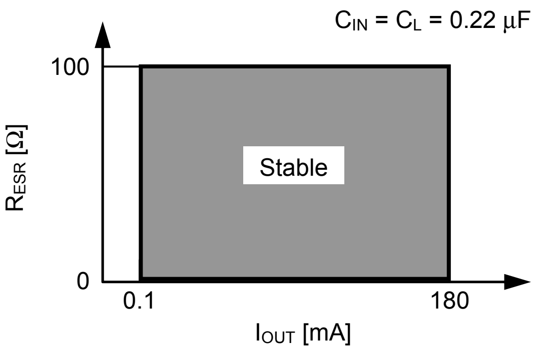
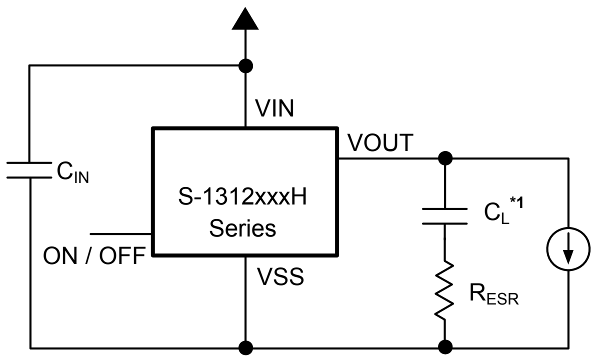


Figure 20



***1.** C_L: TDK Corporation C2012X7R1H224K (0.22 µF)

Figure 21

■ Thermal Characteristics

1. SOT-23-5

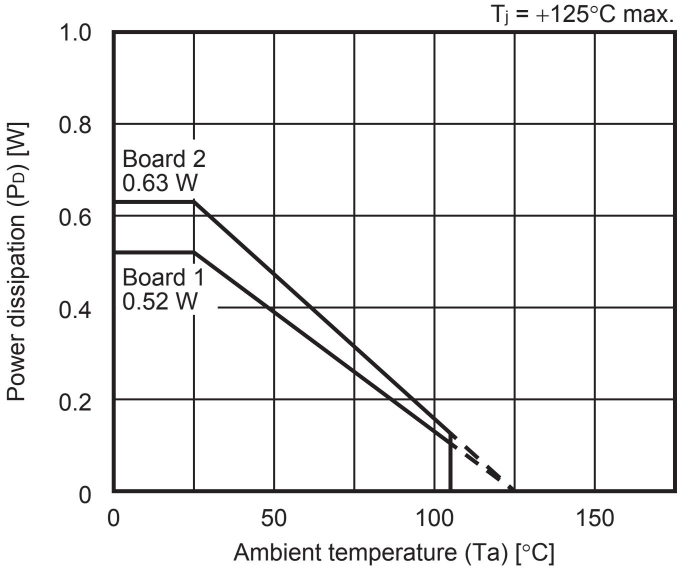


Figure 22 Power Dissipation of Package (When Mounted on Board)

1. 1 Board 1[*1]

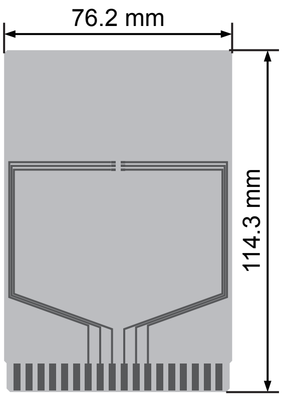


Figure 23

Table 14

Item		Specification
Thermal resistance value (θ_{ja})		192°C/W
Size		114.3 mm × 76.2 mm × t1.6 mm
Material		FR-4
Number of copper foil layer		2
Copper foil layer	1	Land pattern and wiring for testing: t0.070 mm
	2	–
	3	–
	4	74.2 mm × 74.2 mm × t0.070 mm
Thermal via		–

1. 2 Board 2[*1]

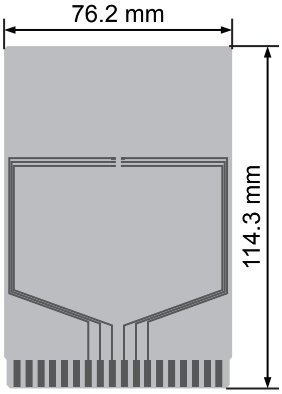


Figure 24

Table 15

Item		Specification
Thermal resistance value (θ_{ja})		160°C/W
Size		114.3 mm × 76.2 mm × t1.6 mm
Material		FR-4
Number of copper foil layer		4
Copper foil layer	1	Land pattern and wiring for testing: t0.070 mm
	2	74.2 mm × 74.2 mm × t0.035 mm
	3	74.2 mm × 74.2 mm × t0.035 mm
	4	74.2 mm × 74.2 mm × t0.070 mm
Thermal via		–

***1.** The board is same in SOT-23-3, SOT-23-5 and SOT-23-6.

2. HSNT-4 (1010)

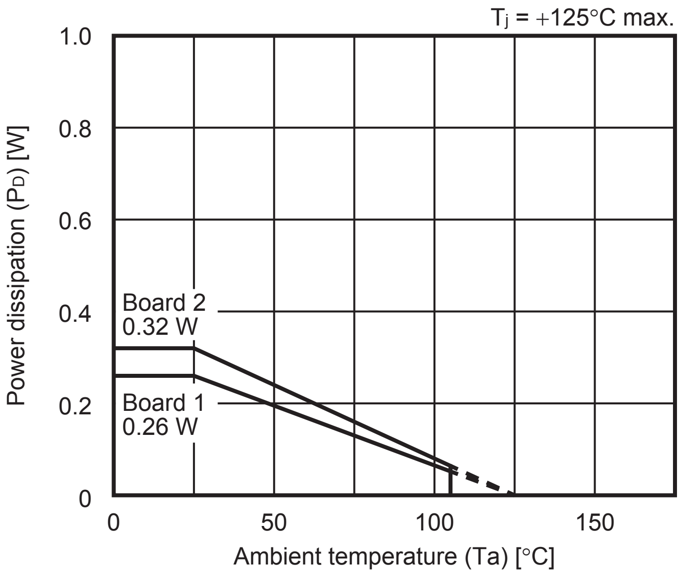


Figure 25 Power Dissipation of Package (When Mounted on Board)

2. 1 Board 1

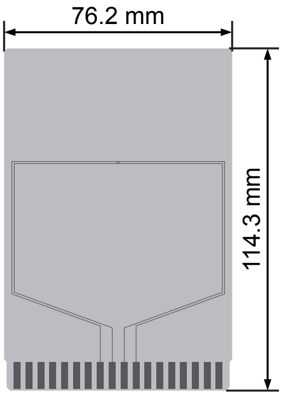


Figure 26

Table 16

Item		Specification
Thermal resistance value (θ_{ja})		378°C/W
Size		114.3 mm × 76.2 mm × t1.6 mm
Material		FR-4
Number of copper foil layer		2
Copper foil layer	1	Land pattern and wiring for testing: t0.070 mm
	2	–
	3	–
	4	74.2 mm × 74.2 mm × t0.070 mm
Thermal via		–

2. 2 Board 2

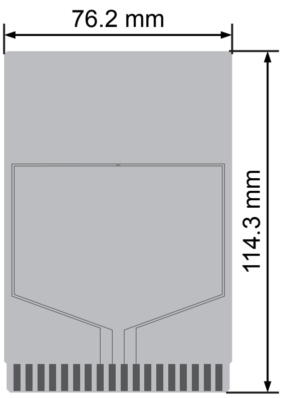
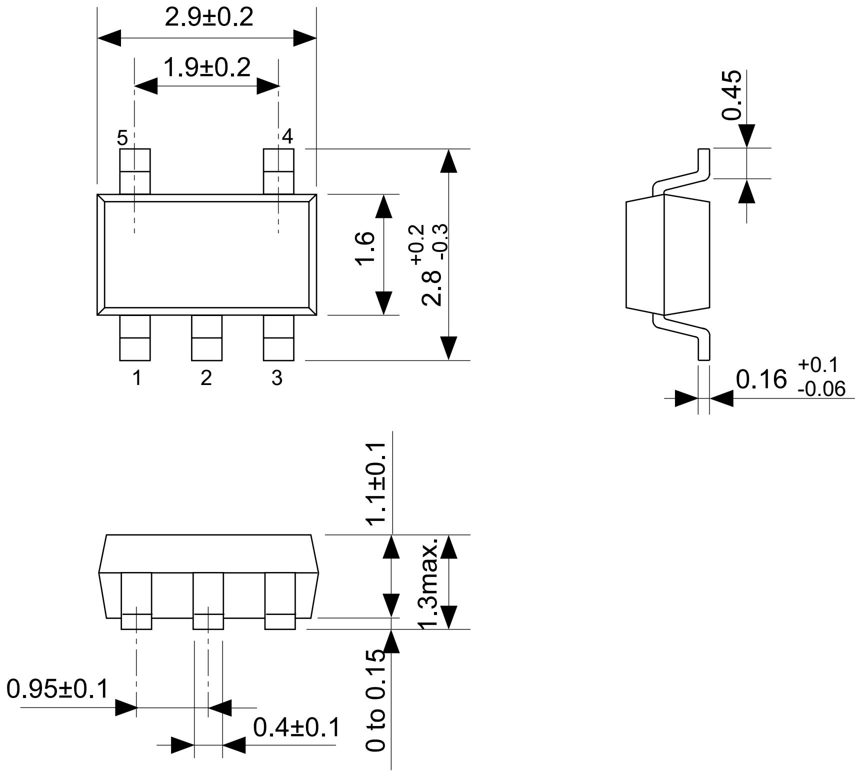


Figure 27

Table 17

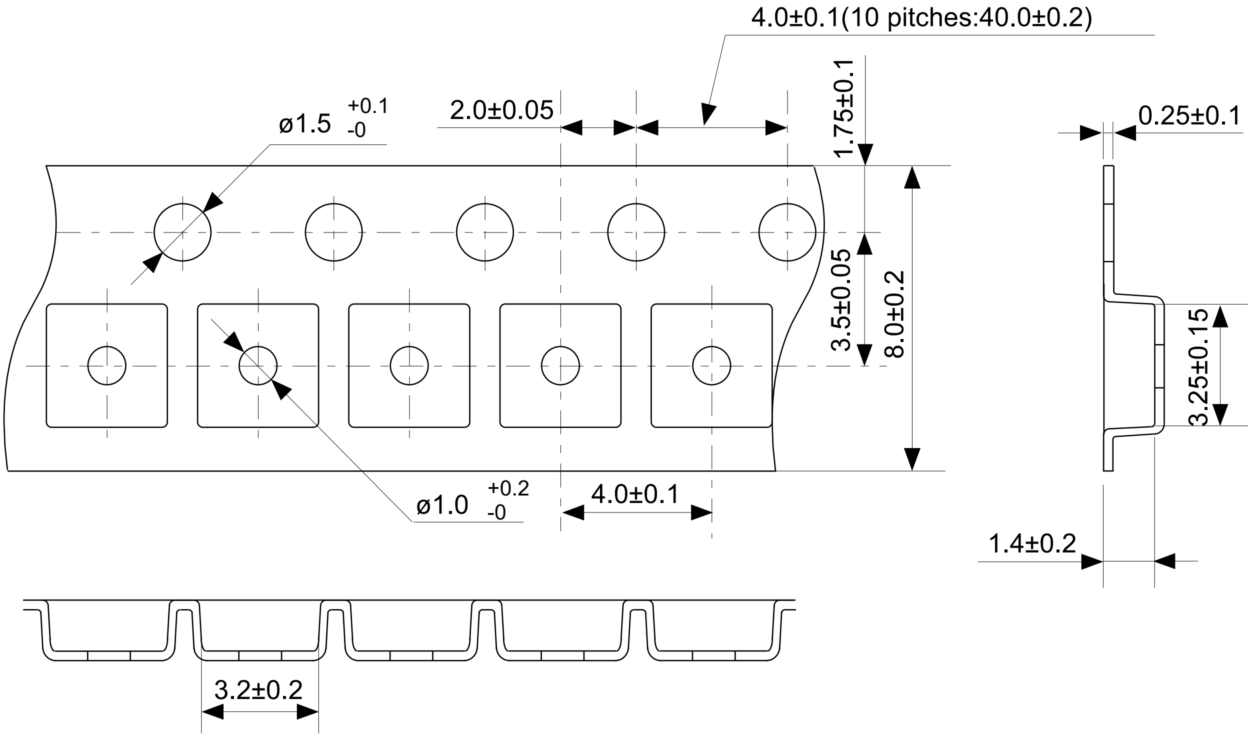
Item		Specification
Thermal resistance value (θ_{ja})		317°C/W
Size		114.3 mm × 76.2 mm × t1.6 mm
Material		FR-4
Number of copper foil layer		4
Copper foil layer	1	Land pattern and wiring for testing: t0.070 mm
	2	74.2 mm × 74.2 mm × t0.035 mm
	3	74.2 mm × 74.2 mm × t0.035 mm
	4	74.2 mm × 74.2 mm × t0.070 mm
Thermal via		–

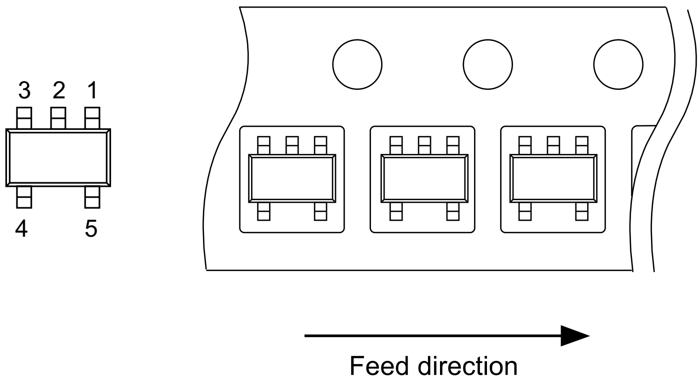


No. MP005-A-P-SD-1.2

TITLE	SOT235-A-PKG Dimensions
No.	MP005-A-P-SD-1.2
SCALE	
UNIT	mm

SII Semiconductor Corporation

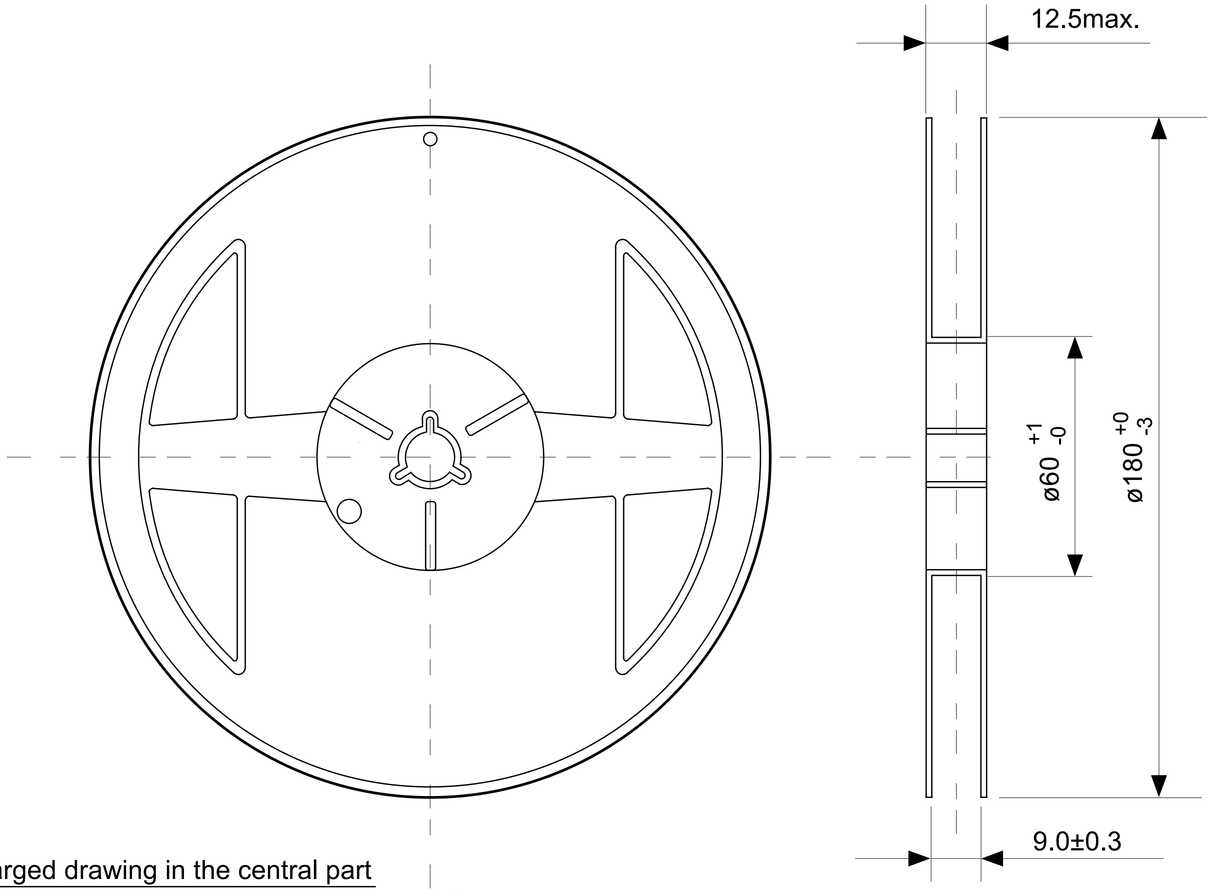




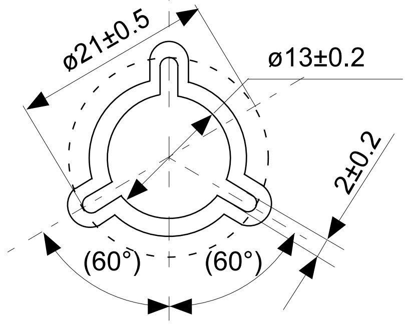
No. MP005-A-C-SD-2.1

TITLE	SOT235-A-Carrier Tape
No.	MP005-A-C-SD-2.1
SCALE	
UNIT	mm

SII Semiconductor Corporation

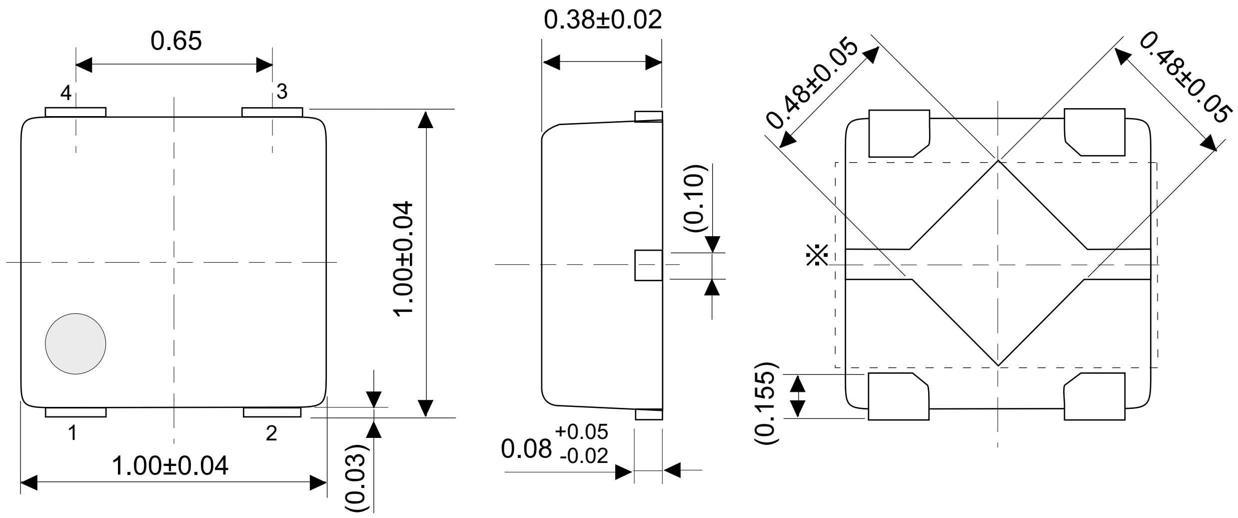


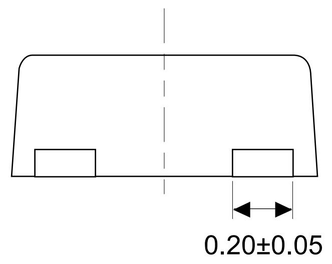
Enlarged drawing in the central part



No. MP005-A-R-SD-1.1

TITLE	SOT235-A-Reel		
No.	MP005-A-R-SD-1.1		
SCALE		QTY.	3,000
UNIT	mm		
SII Semiconductor Corporation			



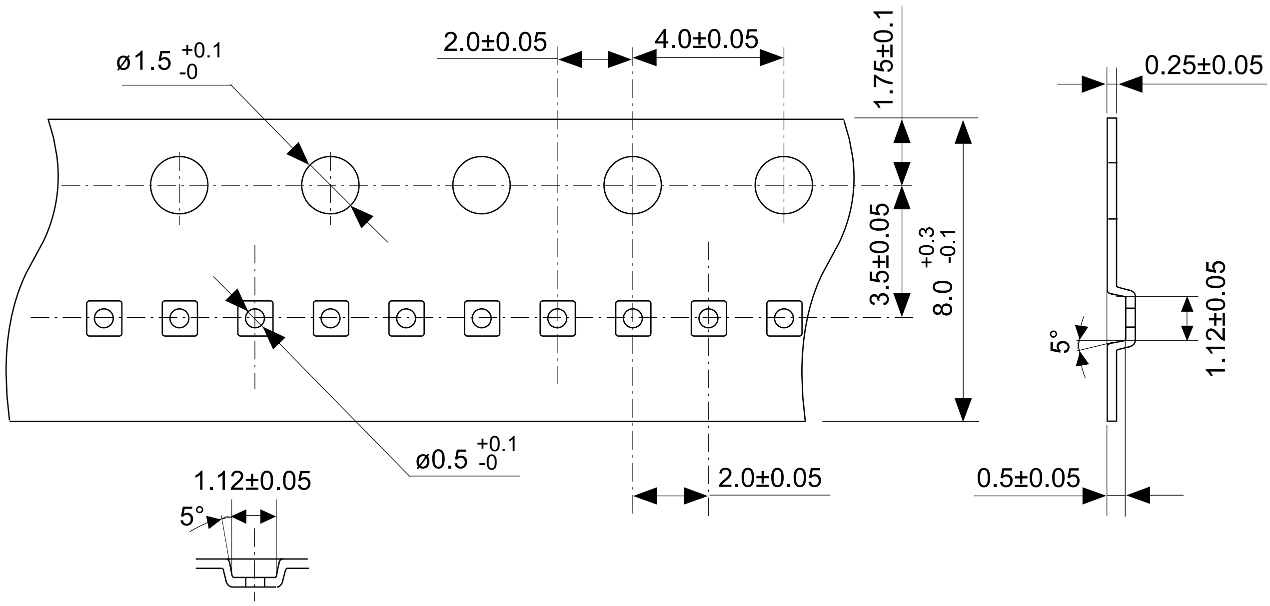


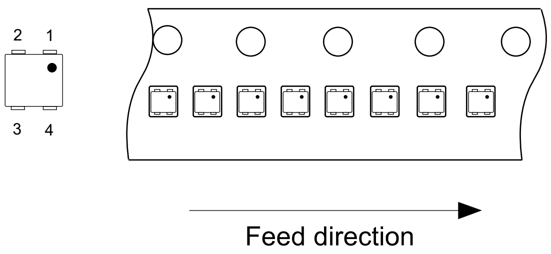
※ The heat sink of back side has different electric potential depending on the product.
Confirm specifications of each product.
Do not use it as the function of electrode.

No. PL004-A-P-SD-1.0

TITLE	HSNT-4-B-PKG Dimensions
No.	PL004-A-P-SD-1.0
SCALE	
UNIT	mm

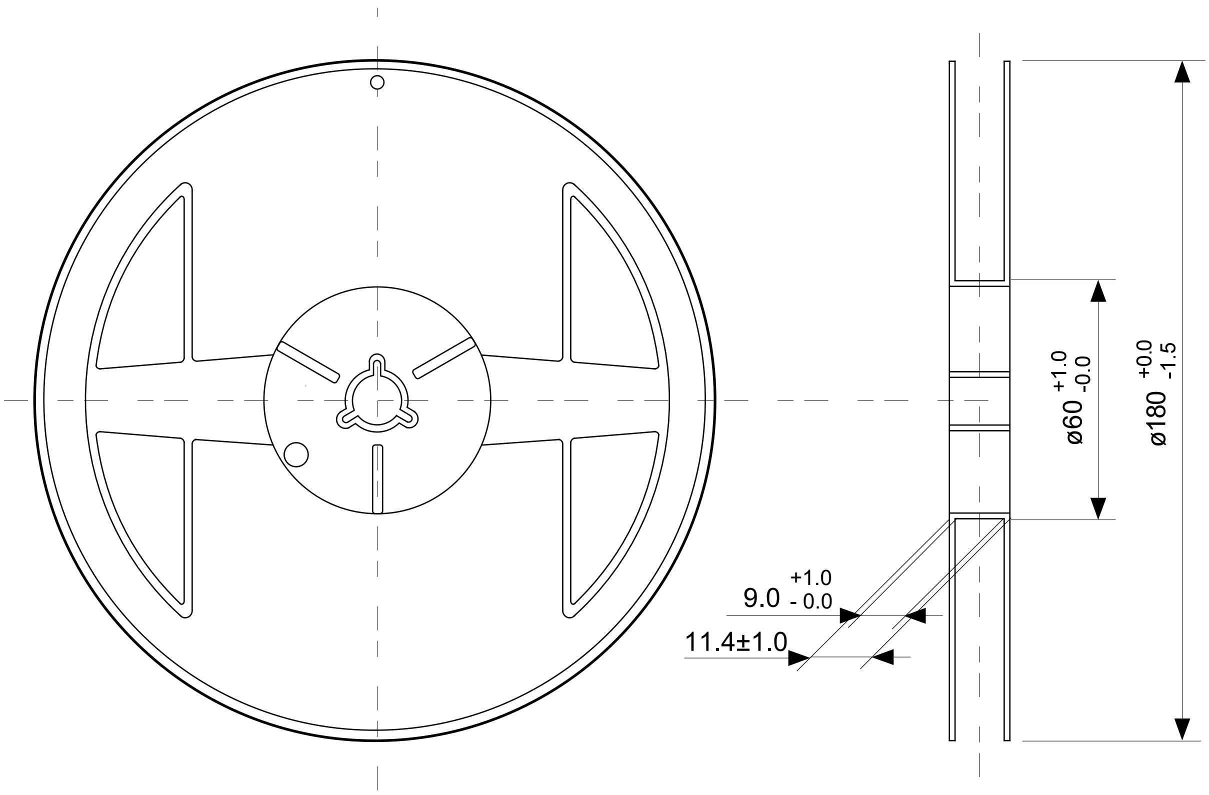
SII Semiconductor Corporation



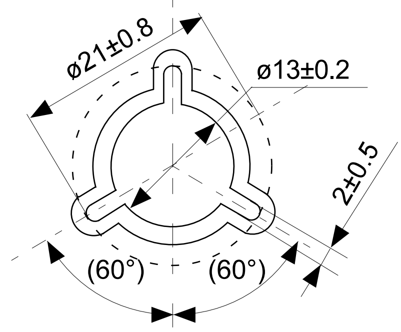


No. PL004-A-C-SD-1.0

TITLE	HSNT-4-B-Carrier Tape
No.	PL004-A-C-SD-1.0
SCALE	
UNIT	mm
SII Semiconductor Corporation	



Enlarged drawing in the central part

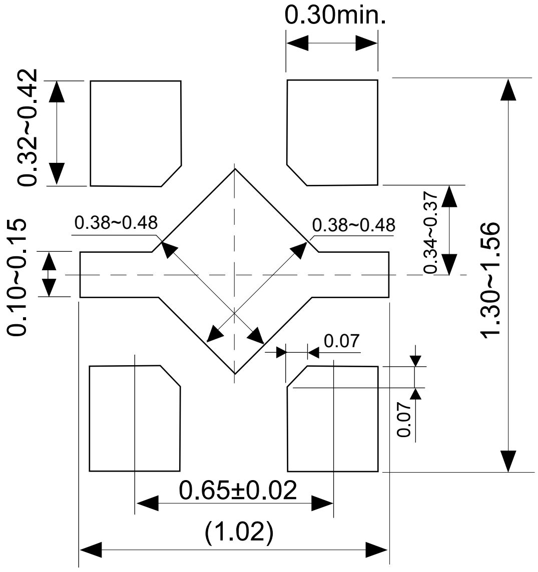


No. PL004-A-R-SD-1.0

TITLE	HSNT-4-B-Reel		
No.	PL004-A-R-SD-1.0		
SCALE		QTY.	10,000
UNIT	mm		

SII Semiconductor Corporation

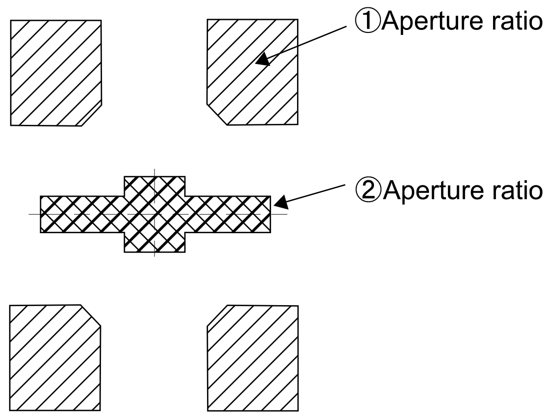
Land Pattern



Caution It is recommended to solder the heat sink to a board in order to ensure the heat radiation.

注意　放熱性を確保する為に、PKGの裏面放熱板（ヒートシンク）を基板に半田付けする事を推奨いたします。

Metal Mask Pattern



Caution ① Mask aperture ratio of the lead mounting part is 100%.
② Mask aperture ratio of the heat sink mounting part is 40%.
③ Mask thickness: t0.10mm to 0.12 mm

注意 ①リード実装部のマスク開口率は100%です。
②放熱板実装のマスク開口率は40%です。
③マスク厚み：t0.10mm ~ 0.12 mm

No. PL004-A-L-SD-2.0

TITLE	HSNT-4-B -Land Recommendation
No.	PL004-A-L-SD-2.0
SCALE	
UNIT	mm

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